

**MOTOROLA**

Advance Information

PLL Tuning Circuit with 1.3 GHz Prescaler and D/A Converters for Automatic Tuner Alignment

The MC44864 is a tuning circuit for TV applications. This device contains a PLL section and a DAC section and is MCU controlled through an I²C Bus.

The PLL section contains all the functions required to control the VCO of a TV tuner. The IC generates the tuning voltage and the additional control signals, such as band switching voltages.

The D/A section generates three additional varactor voltages to feed all of the varactors of the tuner with individually optimized control voltages (automatic tuner adjustment). The MC44864 is manufactured on a single silicon chip using Motorola's high density bipolar process, MOSIAC™ (Motorola Oxide Self-Aligned Implanted Circuits).

- Complete Single Chip System for MPU Control
- Selectable +8 Prescaler Accepts Frequencies up to 1.3 GHz
- 15 Bit Programmable Divider Accepts Input Frequencies up to 165 MHz
- Programmable Reference Divider
- 3-State Phase/Frequency Comparator
- Operational Amplifier for Direct Varactor Control with Low Saturation Voltage
- Four Output Buffers (15 mA)
- Output Options for 62.5 kHz, Reference Frequency and the Programmable Divider
- The HF Input is Symmetrical
- Three 6 Bit DACs for Automatic Tuner Adjustment Allowing Use of Non-Matched Varactors
- Better Tuner Performances Through Optimum Filter Response
- I²C Bus Controlled
- Four Chip Addresses for the PLL Section
- Four Chip Addresses for the D/A Section
- ESD Protected to MIL-STD-883C, Method 3015.7 (2,000 V, 1.5 kΩ, 150 pF)

MAXIMUM RATINGS (T_A = 25°C, unless otherwise noted.)

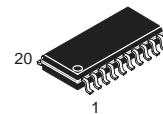
Rating	Pin	Value	Unit
Power Supply Voltage (V _{CC1})	9	6.0	V
Band Buffer "Off" Voltage	14 – 17	15	V
Band Buffer "On" Current	14 – 17	20	mA
Operational Amplifier Power Supply Voltage (V _{CC2})	4	36	V
Operational Amplifier Short Circuit Duration (0 to V _{CC2})	5 – 8	Continuous	S
Storage Temperature	–	–65 to +150	°C
Operating Temperature Range	–	0 to +70	°C

NOTE: ESD data available upon request.

MC44864

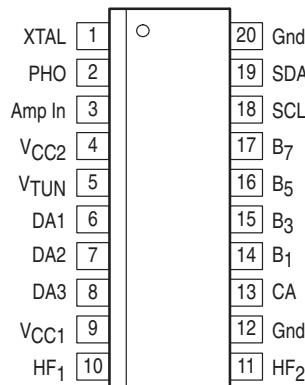
PLL TUNING CIRCUIT WITH 1.3 GHz PRESCALER AND D/A CONVERTERS

SEMICONDUCTOR TECHNICAL DATA



M SUFFIX
PLASTIC PACKAGE
CASE 967
(EIAJ-20)

PIN CONNECTIONS

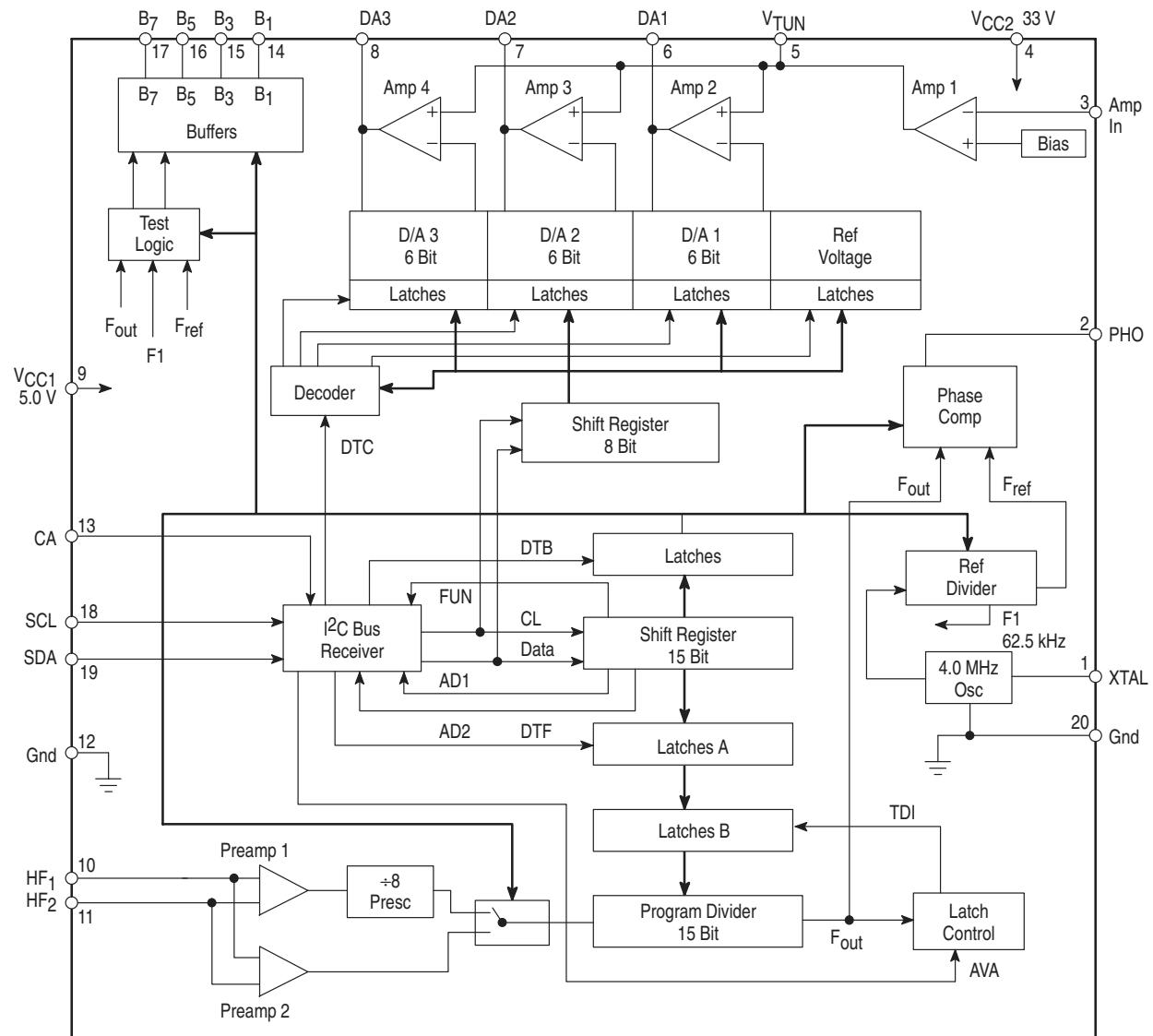


(Top View)

ORDERING INFORMATION

Device	Operating Temperature Range	Package
MC44864M	T _A = 0° to +70°C	EIAJ-20

Representative Block Diagram



This device contains 3,551 active transistors.

MC44864

ELECTRICAL CHARACTERISTICS ($V_{CC1} = 5.0$ V, $V_{CC2} = 32$ V, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

Characteristic	Pin	Min	Typ	Max	Unit
V_{CC1} Supply Voltage Range	9	4.5	5.0	5.5	V
V_{CC1} Supply Current ($V_{CC1} = 5.0$ V) ⁽¹⁾⁽²⁾	9	—	50	70	mA
V_{CC2} Supply Voltage Range	4	25	30	35	V
V_{CC2} Supply Current (Output Open)	4	—	1.3	2.5 ⁽⁴⁾	mA
Band Buffer Leakage Current when "Off" at 12 V	14 – 17	—	0.01	1.0	μA
Band Buffer Saturation Voltage when "On" at 15 mA	14 – 17	—	1.8	2.0	V
Data/Clock Current at 0 V	18, 19	–10	—	0	μA
Clock Current at 5.0 V	18	0	—	1.0	μA
Data Current at 5.0 V Acknowledge "Off"	19	0	—	1.0	μA
Data Saturation Voltage at 15 mA Acknowledge "On"	19	—	1.2	—	V
Data/Clock Input Voltage Low	18, 19	—	—	1.5	V
Data/Clock Input Voltage High	18, 19	3.0	—	—	V
Clock Frequency Range	18	—	—	100	kHz
Phase Detector Current in High Impedance State	2	–15	—	15	nA
Oscillator Frequency Range	1, 2	3.5	4.0	4.1	MHz
Phase Detector High-State Source Current (@ 1.5 V)	2	–2.5	—	–0.5	mA
Phase Detector Low-State Sink Current (@ 4.0 V)	2	0.5	—	2.5	mA
Operational Amplifier Internal Reference Voltage	—	2.0	2.5	3.0	V
Operational Amplifier Input Current	3	–15	—	15	nA
DC Open Loop Gain	—	2000	—	—	V/V
Gain Bandwidth Product	—	—	0.2	—	MHz
Phase Margin	—	—	50	—	Deg.
V_{out} Low, Sinking 50 μA	6 – 8	—	0.2	0.5	V
V_{out} High, Sourcing 50 μA ($V_{CC2} - V_{out}$ High)	6 – 8	—	—	1.5	V
Tuning Voltage (DC)	5 – 8	—	—	30	V
D/A Converters Step Size ⁽³⁾	6 – 8	0.5	—	1.5	LSB
D/A Converters Temperature Drift	6 – 8	—	1.0	—	LSB
DAC Offset at $V_{TUN} = 2.5$ V	—	–50	—	50	mV
DAC Offset at $V_{TUN} = 25$ V	—	–700	—	700	mV
DAC Voltages (DC)	6 – 8	—	—	33	V

NOTES: 1. When prescaler "Off", typical supply current is decreased by 10 mA.

2. Band Buffers "Off", 2.4 mA more when one buffer is on.

3. For definition of the LSB, see Figure 9 in the D/A section.

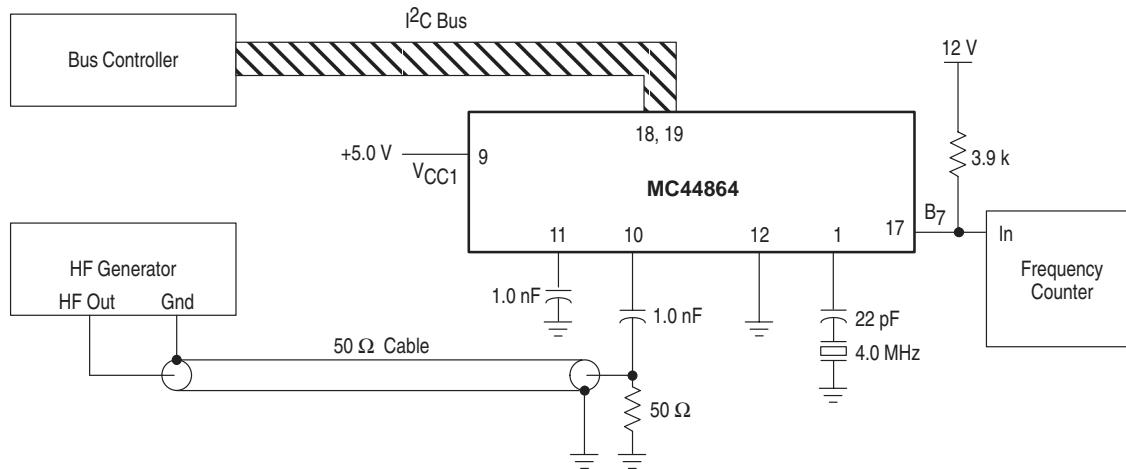
4. 2.5 mA as long as the analog outputs are not in saturation high, which means V_{TUN} , V_{DAC} (Pins 5, 6, 7, 8) lower than $V_{CC2} - 1.5$ V. When all outputs are in saturation high the maximum V_{CC2} current is 5.0 mA.

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HF CHARACTERISTICS (See Figure 1)

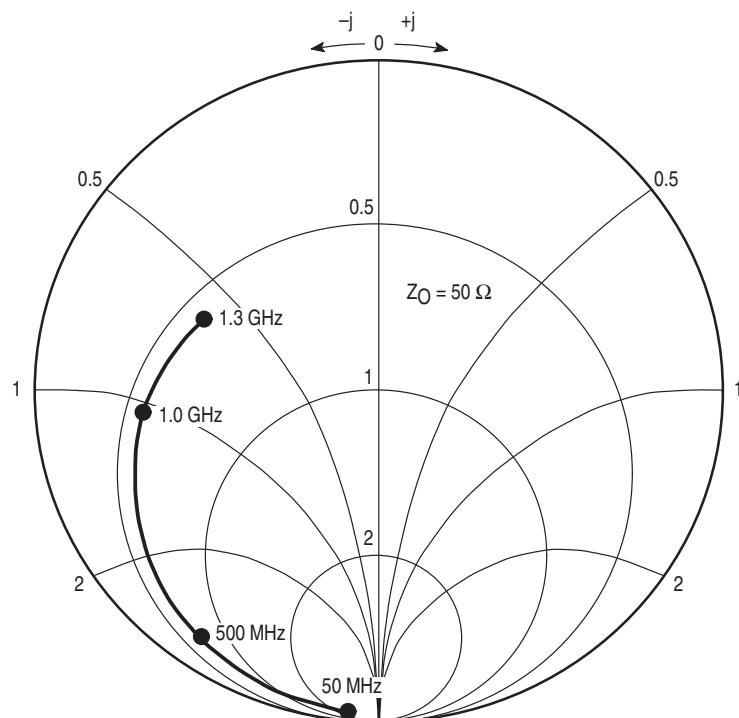
Characteristic	Pin	Min	Typ	Max	Unit
DC Bias	10, 11	—	1.55	—	V
Input Voltage Range					mVrms
10–150 MHz (Prescaler "Off")	10, 11	20	—	315	
80–1000 MHz	10, 11	20	—	315	
1000–1300 MHz	10, 11	50	—	315	

Figure 1. HF Sensitivity Test Circuit



Device is in test mode: B_7 is "On", $R_2 = 1$ and $R_3 = 0$ (see Bus section).
Sensitivity is the level of the HF generator on 50Ω load (without MC44864 load).

Figure 2. Typical HF Input Impedance



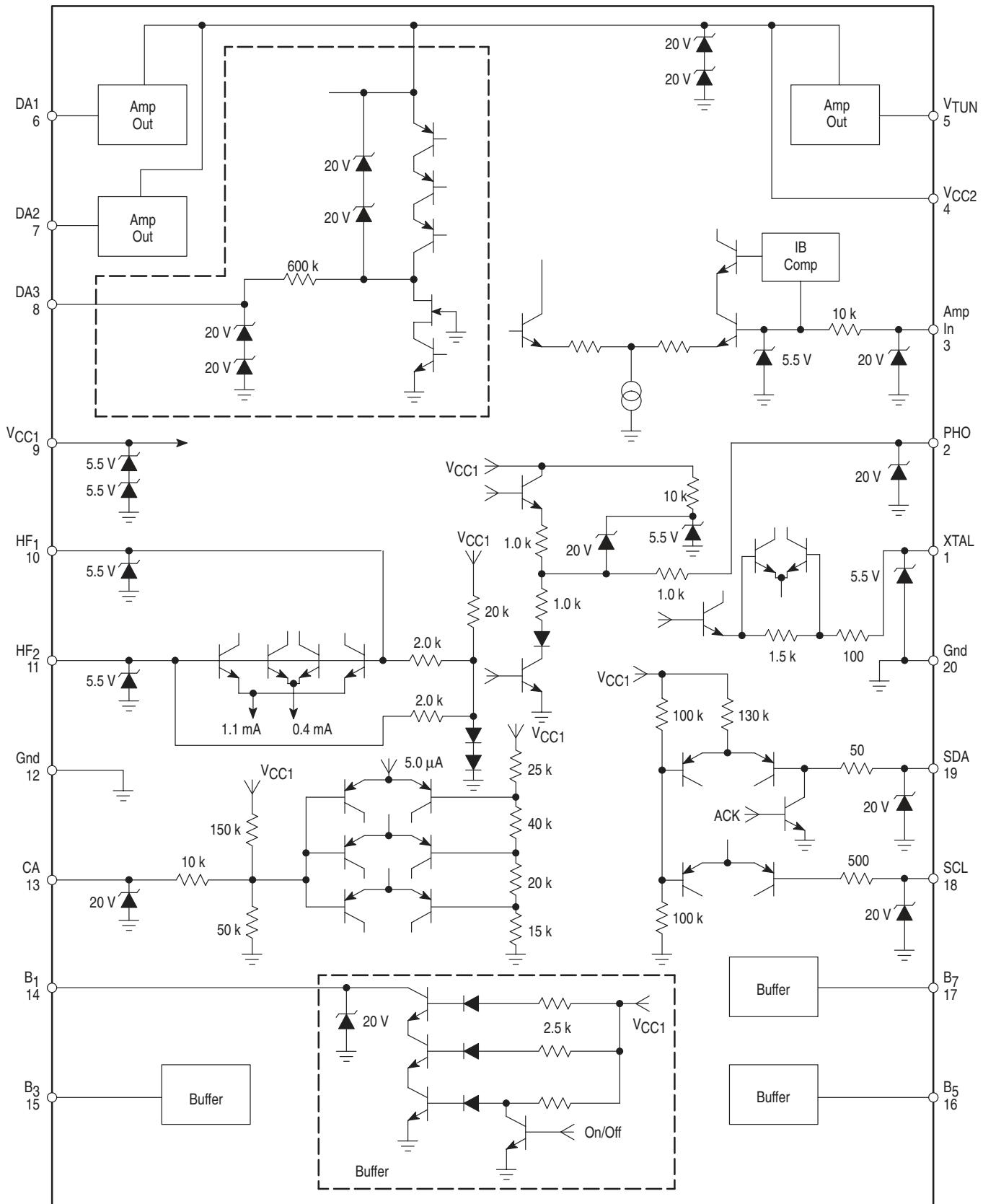
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PIN FUNCTION DESCRIPTION

Pin	Symbol	Description
6, 7, 8	DA1, DA2, DA3	D/A output control voltages
9	VCC1	Positive supply of the circuit (except DACs)
10, 11	HF ₁ , HF ₂	HF input from local oscillator
12, 20	Gnd	Ground
13	CA	Chip Address
14, 15, 16, 17	B ₁ , B ₃ , B ₅ , B ₇	Band buffer output can drive 15 mA
18	SCL	Clock input (supplied by the microprocessor via Bus)
19	SDA	Data input (bus)
1	XTAL	Crystal oscillator (typically 4.0 MHz)
2	PHO	Phase comparator output
3	Amp In	Negative operational amplifier input
4	VCC2	Operational amplifier positive supply
5	V _{TUN}	Operational amplifier output which provides the tuning voltage

MC44864

Figure 3. Pin Circuit Schematic



FUNCTIONAL DESCRIPTION

A representative block diagram and a typical system application are shown in Figures 4 and 5. A discussion of the features and function of the internal blocks is given below.

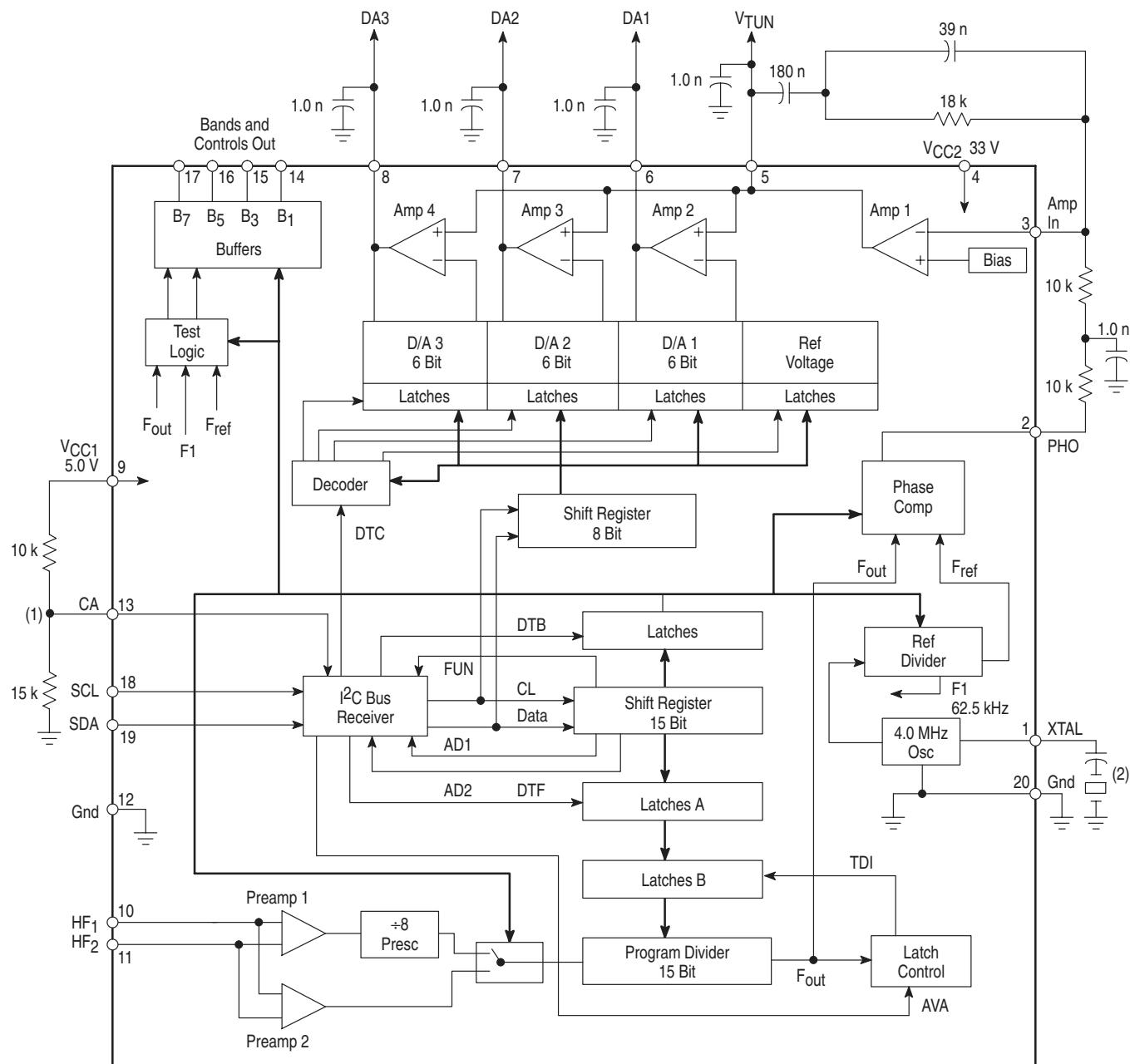
Automatic Tuner Alignment

The circuit generates the tuning voltage through the PLL. The output voltages of the D/A converters are equal to the tuning voltage plus a positive or negative offset of up to 31 steps. During the automatic alignment one first lets the PLL lock to the appropriate frequency and then searches for the

optimum value of the other varactor voltages. The digital word for each voltage value is stored in a nonvolatile memory (NVM). Hence, for each frequency point to be adjusted, three times 6 bits of information have to be stored (plus 2 bits for the DAC range).

The information stored in the NVM reflects the characteristic of the individual tuner. For this reason, the NVM is preferably situated inside the tuner and is also controlled by the I²C Bus.

Figure 4. Block Diagram



NOTES:

- 1. Pin 13: Short to V_{CC} for addresses CC, CE Resistors $\pm 10\%$ for addresses C8, CA (values 10 k and 15 k) for test only Open or 1.0 nF to Gnd for addresses C4, C6 Short to Gnd for addresses C0, C2
- for addresses CC, CE
for addresses C8, CA (values 10 k and 15 k) for test only
for addresses C4, C6
for addresses C0, C2

2. The crystal may be connected to Pin 20 with no connection to external Gnd.

Figure 5. TV Tuner for Automatic Alignment

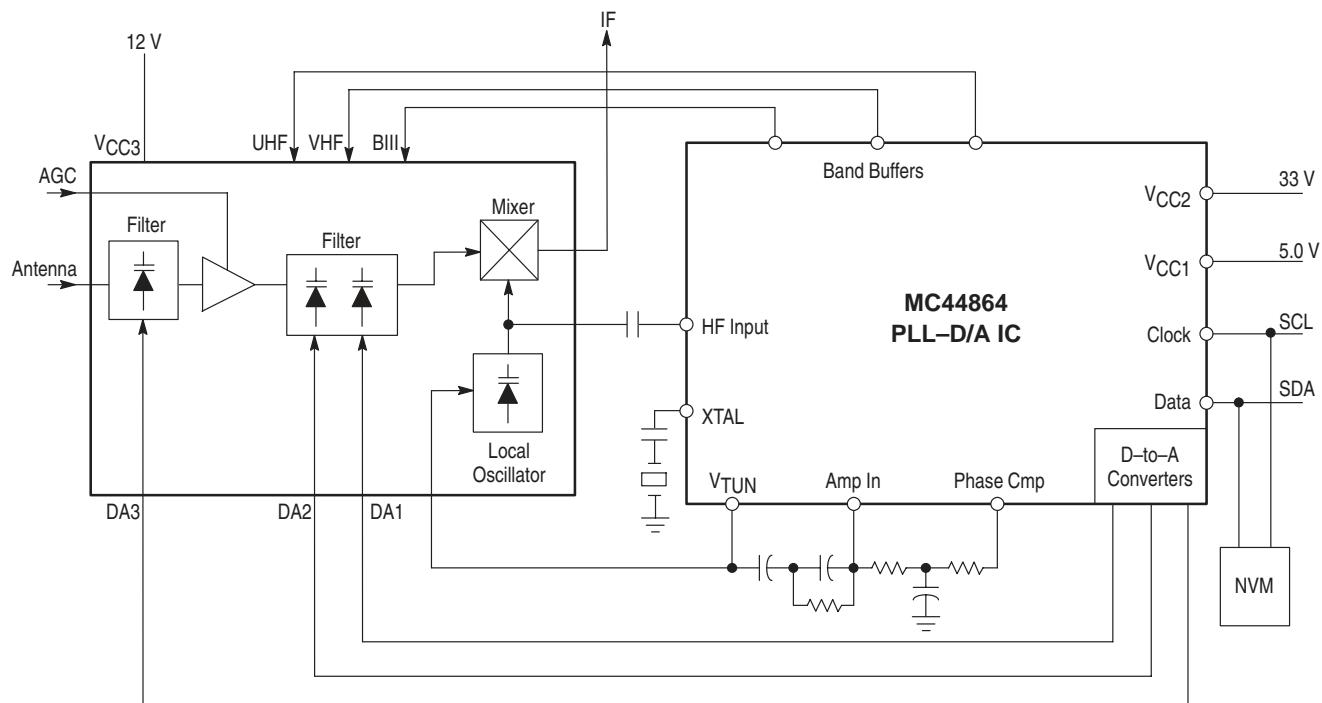


Figure 6. Definition of Bytes

CA1_PLL Chip Address	1	1	0	0	A ₃	A ₂	A ₁	A ₀ = 0	ACK
CO_Control Information	1	R ₆	T	P	R ₃	R ₂	R ₁	R ₀	ACK
BA_Band Information	B ₇	X	B ₅	X	B ₃	X	B ₁	X	ACK
FM_Frequency Information (with MSB)	0	N ₁₄	N ₁₃	N ₁₂	N ₁₁	N ₁₀	N ₉	N ₈	ACK
FL_Frequency Information (with LSB)	N ₇	N ₆	N ₅	N ₄	N ₃	N ₂	N ₁	N ₀	ACK

Chip Addresses

The chip address is programmable by Pin CA.

The PLL addresses C0, C2, C4, C6 are officially allocated to PLL-IC's.

The addresses C8, CA, CC, CE are not officially allocated. Care has to be taken in the application that no conflict occurs with other devices on the same I²C Bus when using the addresses C8 to CE.

CA Pin (13)	A ₃	A ₂	A ₁	A ₀	Address	Function
-0.04 V _{CC1} to 0.1 V _{CC1}	0	0	0	0	C0	1st PLL
	0	0	1	0	C2	1st DAC
Open or 0.2 V _{CC1} to 0.3 V _{CC1}	0	1	0	0	C4	2nd PLL
	0	1	1	0	C6	2nd DAC
0.42 V _{CC1} to 0.75 V _{CC1}	1	0	0	0	C8	3rd PLL
	1	0	1	0	CA	3rd DAC
0.9 V _{CC1} to 1.2 V _{CC1}	1	1	0	0	CC	4th PLL
	1	1	1	0	CE	4th DAC

PLL SECTION

Data Format and Bus Receiver

The circuit receives the information for tuning and control via I²C Bus. The incoming information is treated in the bus receiver. The definition of the permissible bus protocol is shown in the four examples below:

- Ex. 1 STA CA1 CO BA STO
- Ex. 2 STA CA1 FM FL STO
- Ex. 3 STA CA1 CO BA FM FL STO
- Ex. 4 STA CA1 FM FL CO BA STO

STA = Start Condition

STO = Stop Condition

CA1 = Chip Address Byte of the PLL Section

CO = Data Byte for Control Information

BA = Band Information

FM = Data Byte for Frequency Information (MSB's)

FL = Data Byte for Frequency Information (LSB's)

Figure 6 shows the five bytes of information that are needed for circuit operation: there is a chip address, two bytes of control and band information and two bytes of frequency information.

After the chip address, two or four data bytes may be received: if three data bytes are received, the third data byte is ignored. If five or more data bytes are received, the fifth and following data bytes are ignored and the last acknowledge pulse is sent at the end of the fourth data byte.

The first and the third data bytes contain a function bit F. If the function bit F = 0, frequency information is acknowledged and if F = 1, control/band information is acknowledged.

If the address is correct (signal AD1) the information is loaded into latches.

A function bit in the first and third data byte is used to pass this data either into the latches of the programmable divider (signal DTF) or into the latches for band and control information (signal DTB). The data transfer to the latches (signals DTF and DTB) is initiated after the 2nd and 4th data bytes.

A second string of latches is used for the data transfer into the programmable divider to inhibit the transfer during the preset operation (signal TDI, signal AVA is an internal "address valid" command).

The switching levels of clock and data (Pins 18 and 19) are 0.5 x VCC1.

The control and band information bits have the following functions.

Bits R₀, R₁: Controls Reference Divider Division Ratio

R ₀	R ₁	Division Ratio
0	0	2048
1	0	1024
0	1	512
1	1	256

Bits R₂, R₃: Switches Internal Signals to the Buffer Outputs

R ₂	R ₃	Pin 16	Pin 17
0	0	–	–
0	1	62.5 kHz	–
1	0	F _{ref}	F _{BY2}
1	1	–	–

Bit B₅ has to be "one" when Pin 16 is used to output 62.5 kHz. Bits B₅ and B₇ have to be "one" to output F_{ref} and F_{BY2}. F_{BY2} is the programmable divider output frequency divided by two.

Bits R₂, R₆, T: Controls the Phase Comparator Output Stage

R ₂	R ₆	T	Output State
0	0	0	Normal Operation
0	0	1	"Off" (High Impedance)
0	1	0	High
0	1	1	Low
1	0	0	Normal Operation
1	0	1	"Off"
1	1	0	Normal Operation
1	1	1	"Off"

The Band Buffers

The band buffers are open collector transistors and are active "low" at B_n = 1. They are designed for 15 mA with typical on-voltage of 1.8 V. These buffers are designed to withstand relative high output voltage in the off-state (15 V).

B₅ and B₇ buffers (Pins 16 and 17) may also be used to output internal IC signals (reference frequency and programmable divider output frequency divided by 2) for test purposes.

Buffer B₅ may also be used to output a 62.5 kHz frequency from an intermediate stage of the reference divider. The bits B₅ and B₇ have to be "one" if the buffers are used for these additional functions.

The Programmable Divider

The programmable divider is a presetable down counter. When it has counted to zero it takes its required division ratio out of the latches B. Latches B are loaded from latches A by means of signal TDI which is synchronous to the programmable divider output signal.

Since latches A receive the data asynchronously with the programmable divider, this double latch scheme is needed to assure correct data transfer to the counter.

The division ratio definition is given by:

$$N = 16384 \times N_{14} + 8192 \times N_{13} + \dots + 4 \times N_2 + 2 \times N_1 + N_0$$

Maximum Ratio 32767

Minimum Ratio 256

where N₀ ... N₁₄ are the different bits for frequency information.

The counter reloads correctly as long as its output frequency does not exceed 1.0 MHz.

Division ratios of < 256 are not allowed. At power-up the counter bit N₈ is preset to "1". All other bits are undetermined. In this way, the counter always starts with a division ratio of 256 or higher.

The data transfer between latches A and B (signal TDI) is also initiated by any start condition on the bus.

At power-on the whole bus receiver is reset and the programmable divider is set to a counting ratio of N = 256 or higher.

The Prescaler

The prescaler has a preamplifier and may be bypassed (Bit P). The signal then passes through preamplifier 2.

The table on the following page shows the frequency ranges which may be synthesized with and without prescaler.

The Phase Comparator

The phase comparator is phase and frequency sensitive and has very low output leakage current in the high impedance state.

The Operational Amplifier

The operational amplifier for the tuning voltage is designed for low noise, low input bias current and high power supply rejection. The positive input is biased internally. The operational amplifier needs 30 V supply (VCC2) as minimum voltage for a guaranteed maximum tuning voltage of 28.5 V.

Figure 4 shows the usual filter arrangement. The component values depend very much on the application (tuner characteristic, reference frequency, etc.).

As a starting point for optimization, the component values in Figure 4 may be used for 7.8125 kHz reference frequency in a multiband TV tuner.

The Oscillator

The oscillator uses a 4.0 MHz crystal tied to ground in series with a capacitor. The crystal operates in the series resonance mode.

The crystal is driven through a 1.6 kΩ resistor on chip.

The voltage at Pin 16 "crystal", has low amplitude and low harmonic distortion.

The negative resistance of the oscillator at Pin 1 (XTAL) is about 3.0 kΩ.

Input Data		Ref. Divider Div. Ratio	Ref. Freq. Hz(1)	With Int. Prescaler P = 0		Without Prescaler P = 1	
				Frequency Steps kHz	Max. Input Freq. MHz	Frequency Steps kHz	Max. Input Freq. MHz
0	0	2048	1953.125	15.625	512	1.953125	64
1	0	1024	3906.25	31.25	1024	3.90625	128
0	1	512	7812.5	62.5	1300(2)	7.8125	165(3)
1	1	256	15625.0	125.0	1300(2)	15.625	165(3)

NOTES: 1. With 4.0 MHz Crystal

2. Limit of Prescaler

3. Limit of Programmable Divider

For satellite tuner applications the circuit may be used with an external /4 prescaler and a reference divider ratio of 1024 ($R_0 = 1, R_1 = 0$). In this way, frequencies up to 4.0 GHz can be synthesized with 125 kHz resolution (4.0 MHz crystal).

The same result can be achieved with an external /32 prescaler when the internal prescaler is bypassed ($P = 1$).

The Reference Divider

The reference divider of the MC44864 is programmable (Bits R_0 and R_1) for ratios of 2048, 1024, 512 and 256. This feature makes the circuit versatile.

Bit P: Controls the Prescaler

P	Prescaler Function
0	Prescaler Active
1	Prescaler Bypassed Prescaler Power Supply "Off"

Bits B1, B3, B5, B7: Controls the Band Buffers

B1, B3, B5, B7 = 0 = 1	Buffer "Off" Buffer "On"
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D/A SECTION

Basic Function

The D/A section has four separate chip addresses from the PLL section. Three D-to-A converters that have a resolution of 6 bits (5 bits plus sign) are on chip. The analog output voltages are dc. The converters are buffered to the analog outputs DA1, DA2 and DA3 by operational amplifiers with an output voltage range that is equal to the tuning voltage range (about 0 to 30 V). The operational amplifiers are arranged such that a positive or negative offset can be generated from the tuning voltage.

Data Format and Bus Protocols

The D-to-A information consists of the D/A chip address (CA2) and four data bytes. The first two bits of the data bytes are used as the function address. Thus the bytes C1, C2 and

C3 contain the address for the individual converter and the 6 bits to be converted. Bit D5 is the sign (log "1" for positive offset, log "0" for negative offset) and the bits D0 to D4 determine the number of steps to be made as an offset from the tuning voltage. The bits S0 and S1 in the data byte RA define the step size (V_{step}) and the range of the converters (see Figures 8 and 9). The range is the same for all converters.

After the chip address (CA2) is acknowledged, up to four data bytes may be received by the IC. If more than four bytes are received, the fifth and following bytes are ignored and the last acknowledge pulse is sent after the fourth data byte. The data transfer to the converters (signal DTC) is initiated each time a complete data byte is received.

The following shows some examples of the permissible bus protocols of the D-to-A section. The data bytes may be sent to the IC in random order with up to four in one sequence. The same converter may be loaded up to four times as shown in example 6. Below are 6 examples of permissible bus protocols.

Ex. 1 STA	CA2	C1	STO			
Ex. 2 STA	CA2	C1	C2	STO		
Ex. 3 STA	CA2	C1	C2	C3	STO	
Ex. 4 STA	CA2	C1	C2	C3	RA	STO
Ex. 5 STA	CA2	RA	C1	C2	C3	STO
Ex. 6 STA	CA2	C1	C1	C1	C1	STO

STA = Start Condition

STO = Stop Condition

CA2 = Chip Address Byte for D/A Section

C1, C2, C3 = Data Bytes for D/A Converters

RA = Data Byte for Range

Figure 7. Definition of Bytes

CA2_D/A Chip Address	1	1	0	0	A ₂	A ₁	A ₀ = 0	ACK
C1_Converter 1	0	0	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀ ACK
C2_Converter 2	0	1	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀ ACK
C3_Converter 3	1	0	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀ ACK
RA_Range Selection	1	1	X	X	X	X	S ₁	S ₀ ACK

Figure 8. Output Voltage (D/A Converters)

$V_{DA} = V_{TUN} \pm V_{step} (D_0 + 2 D_1 + 4 D_2 + 8 D_3 + 16 D_4)$
$D_5 = 1$ positive sign; $D_5 = 0$ negative sign
V_{TUN} : Tuning Voltage set by PLL
V_{step} : Voltage Step (LSB) of the D/A Converters

Figure 9. Range Selection of the D/A Converters

Input Data		Typ. Step Size V_{step}	Guaranteed Range 31 Steps
S_0	S_1		
0	0	225 mV	6.25 V
1	0	125 mV	3.40 V
0	1	70 mV	1.90 V
1	1	40 mV	1.05 V

The D/A Converters

The D/A converters convert 5 bit into analog current of which the polarity is switched by the sixth bit. The reference voltage of the converters is programmed by two bits (S_0, S_1 of the RA-byte) to determine the scaling factor. The analog

currents are then converted into voltages and added to their respective operational amplifier nominal bias. The resulting voltages at Pins 6, 7 and 8 are the tuning voltages (V_{TUN} , see Figure 4) at Pin 5 plus any offset provided by information in the D/A converters.

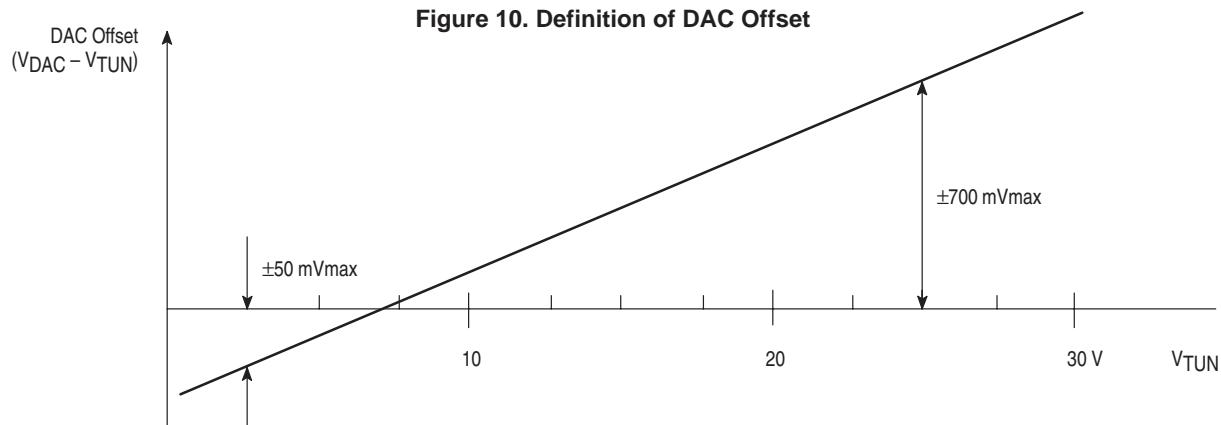
If the data bits D_0 to D_4 are all "0", the three D/A output voltages on Pins 6, 7 and 8 are equal to the tuning voltage (Pin 5) within the DAC offset voltages.

The four amplifiers have the same output characteristics with the maximum output voltage being 1.5 V lower than V_{CC2} in the worst case. The four analog outputs are short-circuit protected. At power-up, the D/A outputs are undetermined.

The D/A converters are guaranteed to be monotonic with a voltage step variation of ± 0.5 LSB.

The D/A converters work correctly as long as the PLL loop is active. V_{TUN} is then between 0.3 V and $V_{CC2} - 1.5$ V. If the loop saturates, the DACs do not work.

The DAC-OFFSET is defined as the difference between the DAC output voltage (with bits D_0 to $D_4 = 0$) and the tuning voltage (PLL active). The DAC operation is guaranteed from 0.3 V to $V_{CC2} - 1.5$ V. On typical samples, the DACs will operate down to 0.2 V.

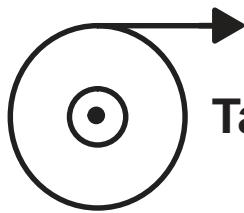
Figure 10. Definition of DAC Offset

Tape and Reel Options

In Brief . . .

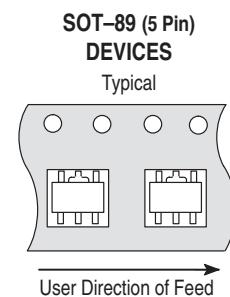
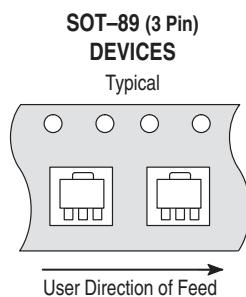
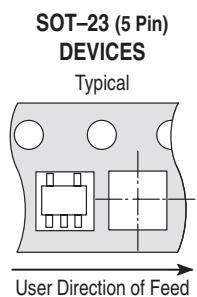
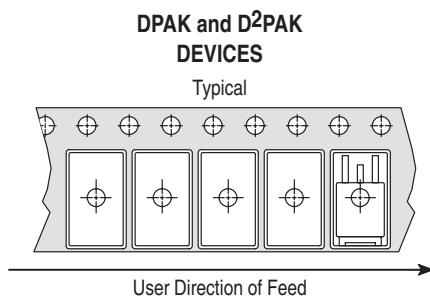
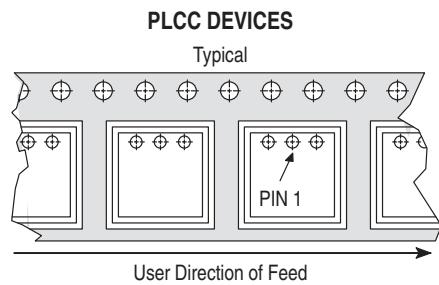
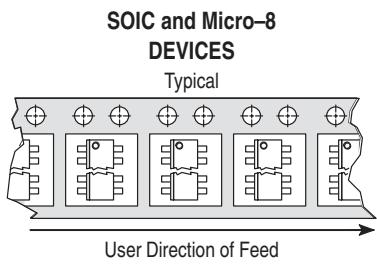
Motorola offers the convenience of Tape and Reel packaging for our growing family of standard integrated circuit products. Reels are available to support the requirements of both first and second generation pick-and-place equipment. The packaging fully conforms to the latest EIA-481A specification. The antistatic embossed tape provides a secure cavity, sealed with a peel-back cover tape.

	Page
Tape and Reel Configurations	12-2
Tape and Reel Information Table	12-4
Analog MPQ Table	12-5



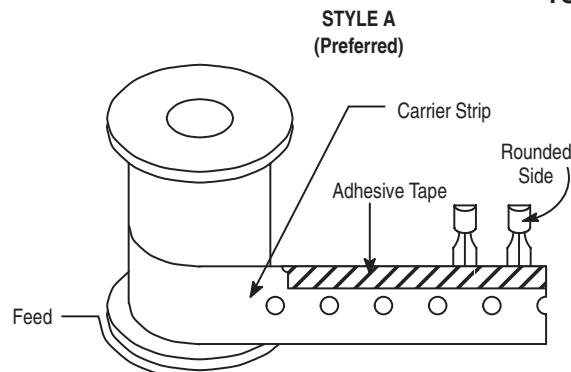
Tape and Reel Configurations

Mechanical Polarization

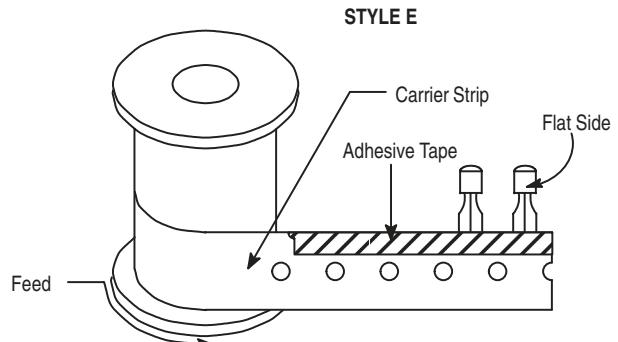


Tape and Reel Configurations (continued)

TO-92 Reel Styles

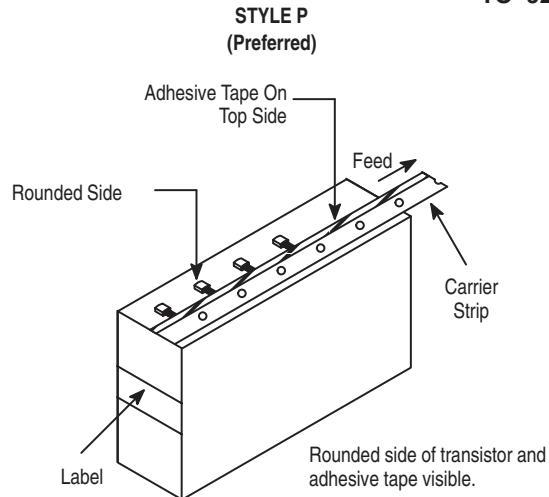


Rounded side of transistor and adhesive tape visible.

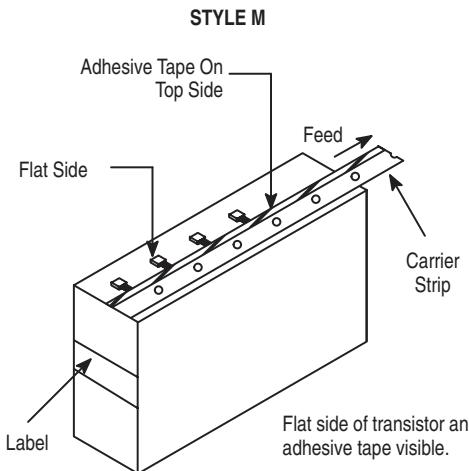


Flat side of transistor and adhesive tape visible.

TO-92 Ammo Pack Styles

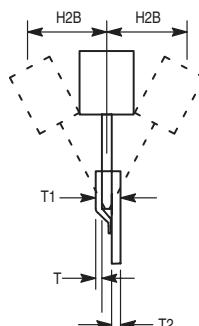
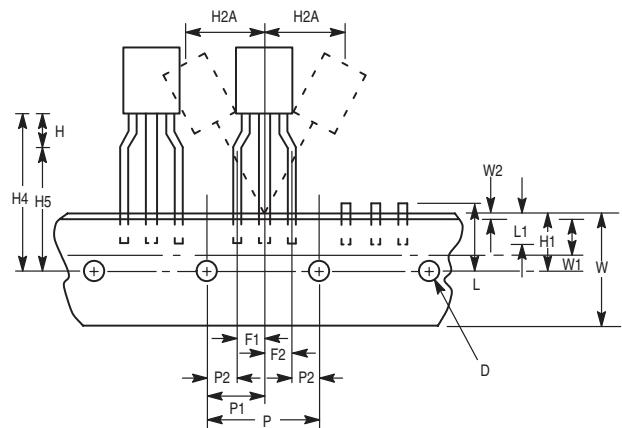


Style P ammo pack is equivalent to Styles A and B of reel pack dependent on feed orientation from box.



Style M ammo pack is equivalent to Style E of reel pack dependent on feed orientation from box.

TO-92 EIA Radial Tape in Fan Fold Box or On Reel



Tape and Reel Information Table

Package	Tape Width (mm)	Devices ⁽¹⁾ per Reel	Reel Size (inch)	Device Suffix
SO-8, SOP-8	12	2,500	13	R2
SO-14	16	2,500	13	R2
SO-16	16	2,500	13	R2
SO-16L, SO-8+8L WIDE	16	1,000	13	R2
SO-20L WIDE	24	1,000	13	R2
SO-24L WIDE	24	1,000	13	R2
SO-28L WIDE	24	1,000	13	R2
SO-28L WIDE	32	1,000	13	R3
Micro-8	12	2,500	13	R2
PLCC-20	16	1,000	13	R2
PLCC-28	24	500	13	R2
PLCC-44	32	500	13	R2
PLCC-52	32	500	13	R2
PLCC-68	44	250	13	R2
PLCC-84	44	250	13	R2
TO-226AA (TO-92) ⁽²⁾	18	2,000	13	RA, RE, RP, or RM (Ammo Pack) only
DPAK	16	2,500	13	RK
D ² PAK	24	800	13	R4
SOT-23 (5 Pin)	8	3,000	7	TR
SOT-89 (3/5 Pin)	12	1,000	7	T1

(1) Minimum order quantity is 1 reel. Distributors/OEM customers may break lots or reels at their option, however broken reels may not be returned.

(2) Integrated circuits in TO-226AA packages are available in Styles A and E only, with optional "Ammo Pack" (Suffix RP or RM). The RA and RP configurations are preferred. For ordering information please contact your local Motorola Semiconductor Sales Office.

Analog MPQ Table

Tape/Reel and Ammo Pack

Package Type	Package Code	MPQ
PLCC		
Case 775	0802	1000/reel
Case 776	0804	500/reel
Case 777	0801	500/reel
SOIC		
Case 751	0095	2500/reel
Case 751A	0096	2500/reel
Case 751B	0097	2500/reel
Case 751G	2003	1000/reel
Case 751D	2005	1000/reel
Case 751E	2008	1000/reel
Case 751F	2009	1000/reel
Micro-8		
Case 846A	-	2500/reel
TO-92		
Case 29	0031	2000/reel
Case 29	0031	2000/Ammo Pack
DPAK		
Case 369A	-	2500/reel
D²PAK		
Case 936	-	800/reel
SOT-23 (5 Pin)		
Case 1212	-	3000/reel
SOT-89 (3 Pin)		
Case 1213	-	1000/reel
SOT-89 (5 Pin)		
Case 1214	-	1000/reel

Packaging Information

In Brief . . .

The packaging availability for each device type is indicated on the individual data sheets and the Selector Guide. All of the outline dimensions for the packages are given in this section.

The maximum power consumption an integrated circuit can tolerate at a given operating ambient temperature can be found from the equation:

$$P_{D(TA)} = \frac{T_{J(max)} - T_A}{R_{\theta JA}(\text{Typ})}$$

where:

$P_{D(TA)}$ = Power Dissipation allowable at a given operating ambient temperature. This must be greater than the sum of the products of the supply voltages and supply currents at the worst case operating condition.

$T_{J(max)}$ = Maximum operating Junction Temperature as listed in the Maximum Ratings Section. See individual data sheets for $T_{J(max)}$ information.

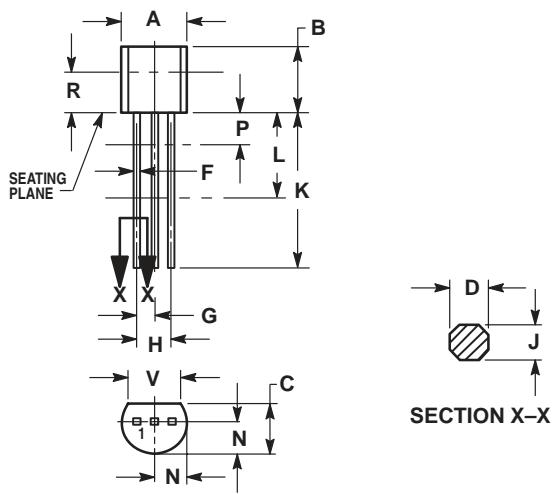
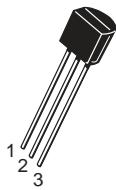
T_A = Maximum desired operating Ambient Temperature

$R_{\theta JA}(\text{Typ})$ = Typical Thermal Resistance Junction-to-Ambient

Case Outline Dimensions

**LP, P, Z SUFFIX
CASE 29-04**

Plastic Package
(TO-226AA/TO-92)
ISSUE AD



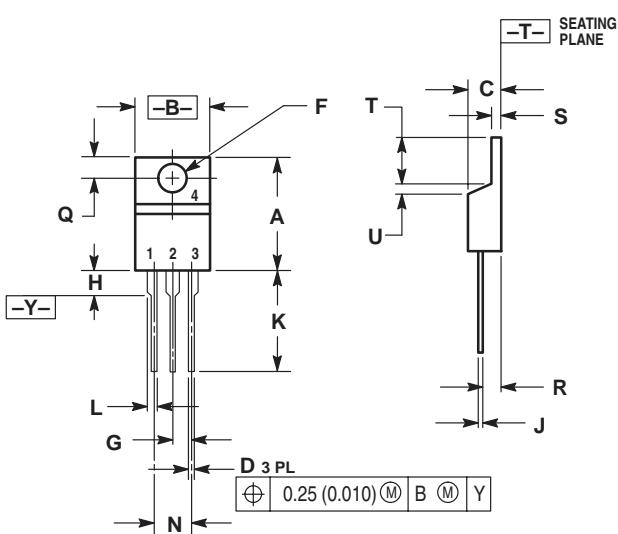
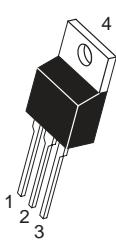
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. DIMENSION F APPLIES BETWEEN P AND L. DIMENSION D AND J APPLY BETWEEN L AND K MINIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.022	0.41	0.55
F	0.016	0.019	0.41	0.48
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	—	12.70	—
L	0.250	—	6.35	—
N	0.080	0.105	2.04	2.66
P	—	0.100	—	2.54
R	0.115	—	2.93	—
V	0.135	—	3.43	—

**KC, T SUFFIX
CASE 221A-06**

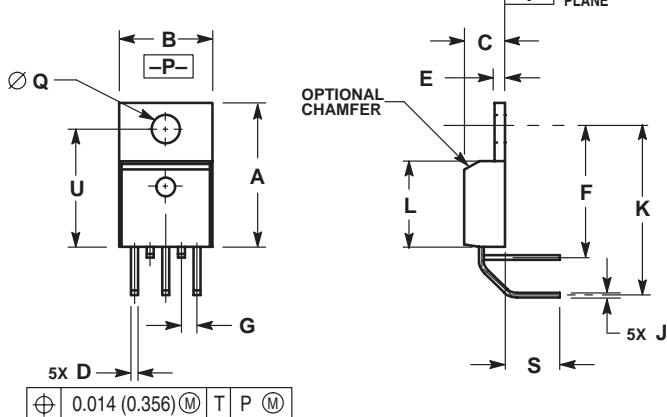
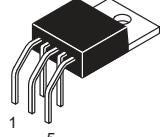
Plastic Package
ISSUE Y



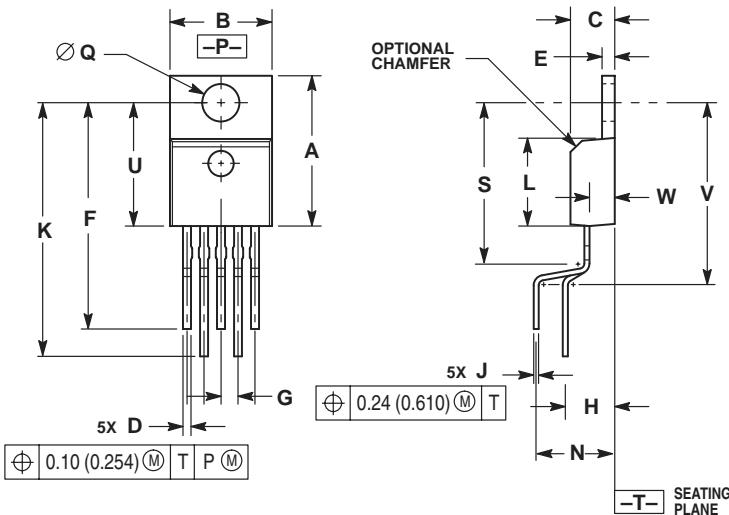
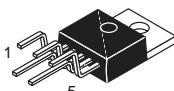
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

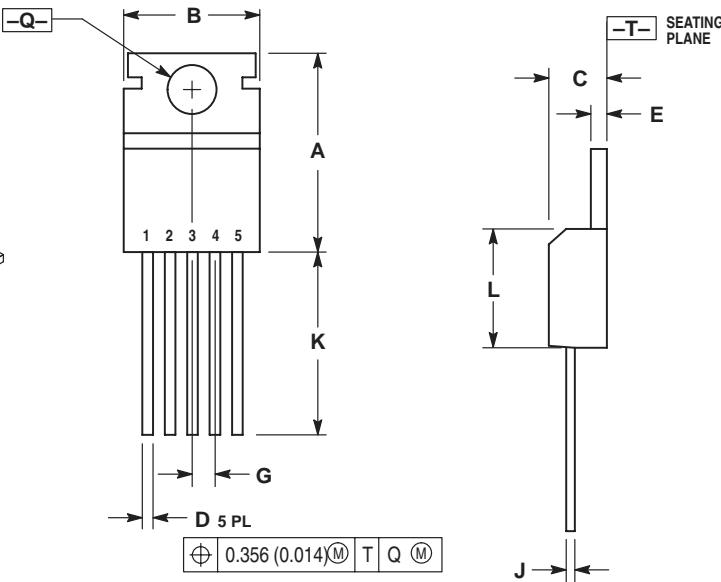
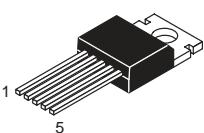
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.560	0.625	14.23	15.87
B	0.380	0.420	9.66	10.66
C	0.140	0.190	3.56	4.82
D	0.020	0.045	0.51	1.14
F	0.139	0.155	3.53	3.93
G	0.100 BSC	—	2.54 BSC	—
H	—	0.280	—	7.11
J	0.012	0.045	0.31	1.14
K	0.500	0.580	12.70	14.73
L	0.045	0.070	1.15	1.77
N	0.200 BSC	—	5.08 BSC	—
Q	0.100	0.135	2.54	3.42
R	0.080	0.115	2.04	2.92
S	0.020	0.055	0.51	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27

TH SUFFIX**CASE 314A-03**Plastic Package
ISSUE D

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.572	0.613	14.529	15.570
B	0.390	0.415	9.906	10.541
C	0.170	0.180	4.318	4.572
D	0.025	0.038	0.635	0.965
E	0.048	0.055	1.219	1.397
F	0.570	0.585	14.478	14.859
G	0.067 BSC		1.702 BSC	
J	0.015	0.025	0.381	0.635
K	0.730	0.745	18.542	18.923
L	0.320	0.365	8.128	9.271
Q	0.140	0.153	3.556	3.886
S	0.210	0.260	5.334	6.604
U	0.468	0.505	11.888	12.827

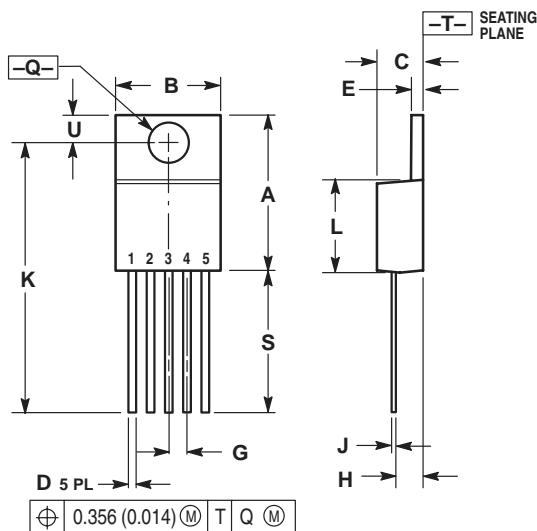
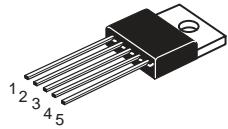
T, TV SUFFIX**CASE 314B-05**Plastic Package
ISSUE J

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.572	0.613	14.529	15.570
B	0.390	0.415	9.906	10.541
C	0.170	0.180	4.318	4.572
D	0.025	0.038	0.635	0.965
E	0.048	0.055	1.219	1.397
F	0.850	0.935	21.590	23.749
G	0.067 BSC		1.702 BSC	
H	0.166 BSC		4.216 BSC	
J	0.015	0.025	0.381	0.635
K	0.900	1.100	22.860	27.940
L	0.320	0.365	8.128	9.271
N	0.320 BSC		8.128 BSC	
Q	0.140	0.153	3.556	3.886
S	—	0.620	—	15.748
U	0.468	0.505	11.888	12.827
V	—	0.735	—	18.669
W	0.090	0.110	2.286	2.794

T SUFFIX**CASE 314C-01**Plastic Package
ISSUE A

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.610	0.625	15.59	15.88
B	0.380	0.420	9.65	10.67
C	0.160	0.190	4.06	4.83
D	0.020	0.040	0.51	1.02
E	0.035	0.055	0.89	1.40
G	0.067 BSC		1.702 BSC	
J	0.015	0.025	0.38	0.64
K	0.500	—	12.70	—
L	0.355	0.370	9.02	9.40
Q	0.139	0.147	3.53	3.73

**T, T1 SUFFIX
CASE 314D-03**
Plastic Package
ISSUE D

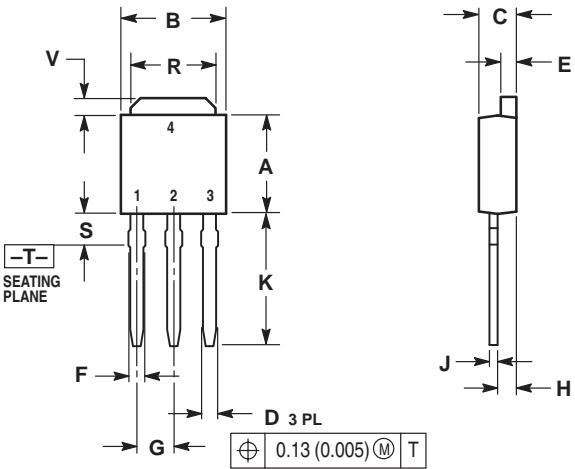
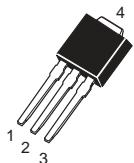


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION D DOES NOT INCLUDE INTERCONNECT BAR (DAMBAR) PROTRUSION. DIMENSION D INCLUDING PROTRUSION SHALL NOT EXCEED 10.92 (0.043) MAXIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.572	0.613	14.529	15.570
B	0.390	0.415	9.906	10.541
C	0.170	0.180	4.318	4.572
D	0.025	0.038	0.635	0.965
E	0.048	0.055	1.219	1.397
G	0.067 BSC		1.702 BSC	
H	0.087	0.112	2.210	2.845
J	0.015	0.025	0.381	0.635
K	1.020	1.065	25.908	27.051
L	0.320	0.365	8.128	9.271
Q	0.140	0.153	3.556	3.886
U	0.105	0.117	2.667	2.972
S	0.543	0.582	13.792	14.783

**DT-1 SUFFIX
CASE 369-07**
Plastic Package
(DPAK)
ISSUE K

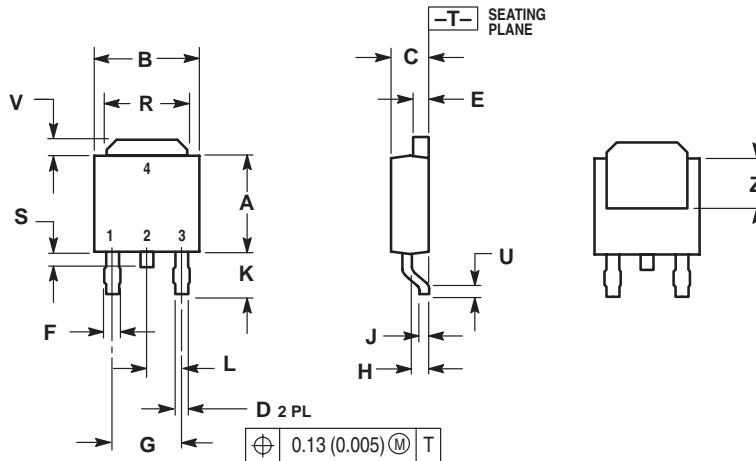
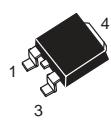


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.090 BSC		2.29 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.350	0.380	8.89	9.65
R	0.175	0.215	4.45	5.46
S	0.050	0.090	1.27	2.28
V	0.030	0.050	0.77	1.27

**DT SUFFIX
CASE 369A-13**
Plastic Package
(DPAK)
ISSUE Y



NOTES:

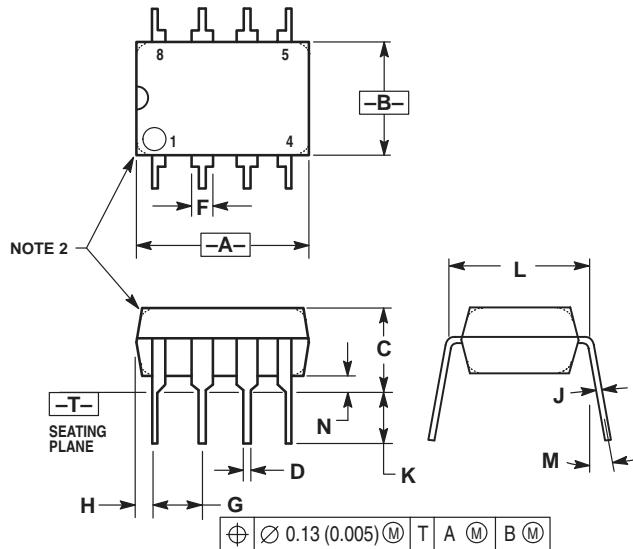
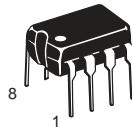
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.175	0.215	4.45	5.46
S	0.020	0.050	0.51	1.27
U	0.020	—	0.51	—
V	0.030	0.050	0.77	1.27
Z	0.138	—	3.51	—

DP1, N, P, P1 SUFFIX**CASE 626-05**

Plastic Package

ISSUE K



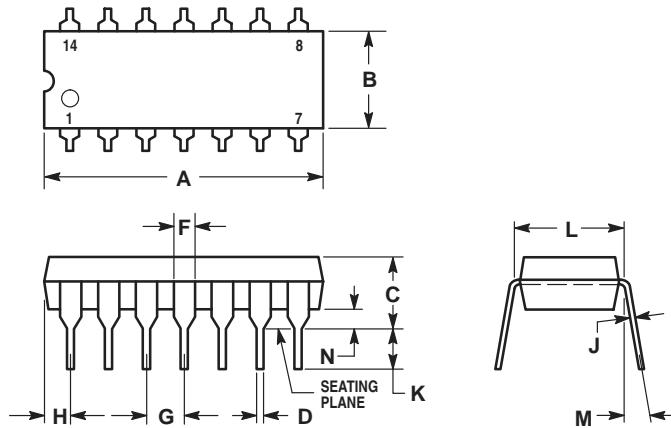
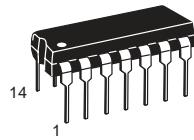
NOTES:

1. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
2. PACKAGE CONTOUR OPTIONAL (ROUND OR SQUARE CORNERS).
3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

N, P, N-14, P2 SUFFIX**CASE 646-06**

Plastic Package

ISSUE L



NOTES:

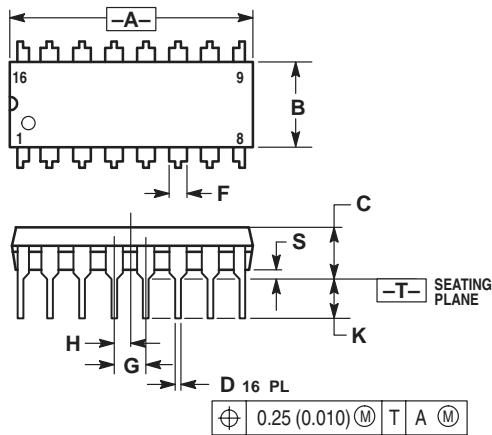
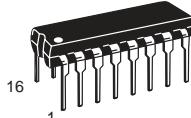
1. LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
4. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	19.56
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.300 BSC		7.62 BSC	
M	0°	10°	0°	10°
N	0.015	0.039	0.39	1.01

DP2, N, P, PC SUFFIX**CASE 648-08**

Plastic Package

ISSUE R



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

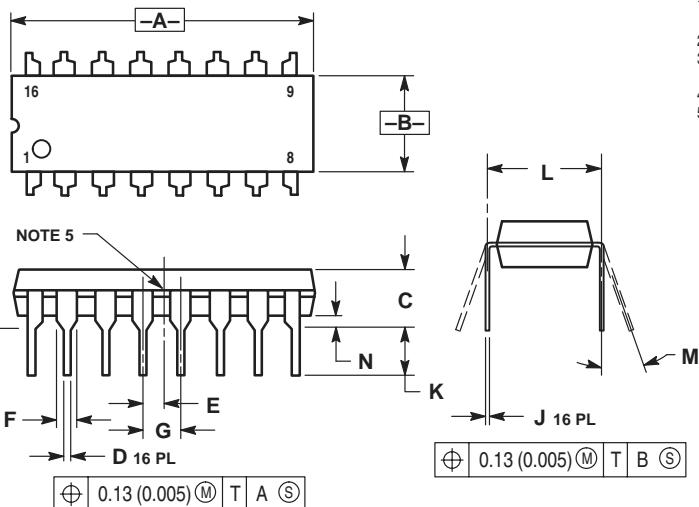
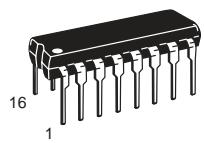
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

B, P, P2, V SUFFIX**CASE 648C-03**

Plastic Package

(DIP-16)

ISSUE C



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. INTERNAL LEAD CONNECTION BETWEEN 4 AND 12 AND 13.

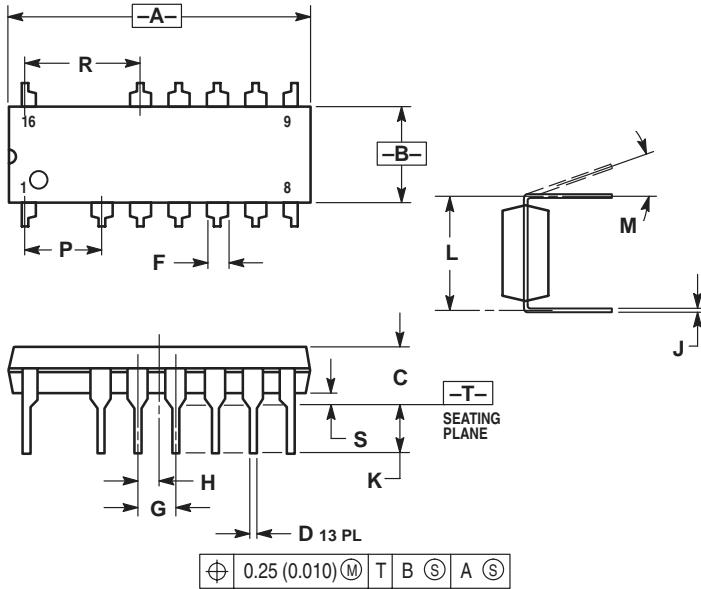
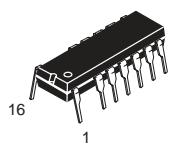
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.840	18.80	21.34
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
E	0.050 BSC		1.27 BSC	
F	0.040	0.70	1.02	1.78
G	0.100 BSC		2.54 BSC	
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.300 BSC		7.62 BSC	
M	0°	10°	0°	10°
N	0.015	0.040	0.39	1.01

P SUFFIX**CASE 648E-01**

Plastic Package

(DIP-16)

ISSUE O



NOTES:

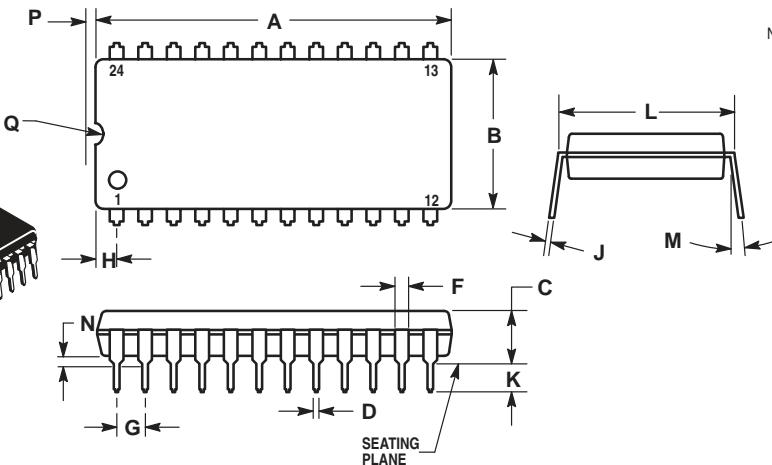
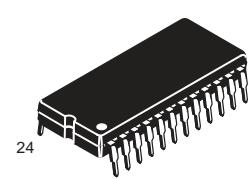
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION A AND B DOES NOT INCLUDE MOLD PROTRUSION.
5. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.25 (0.010).
6. ROUNDED CORNER OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.760	18.80	19.30
B	0.245	0.260	6.23	6.60
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.050	0.070	1.27	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.120	0.140	3.05	3.55
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
P	0.200 BSC		5.08 BSC	
R	0.300 BSC		7.62 BSC	
S	0.015	0.035	0.39	0.88

P SUFFIX**CASE 649-03**

Plastic Package

ISSUE D



NOTES:

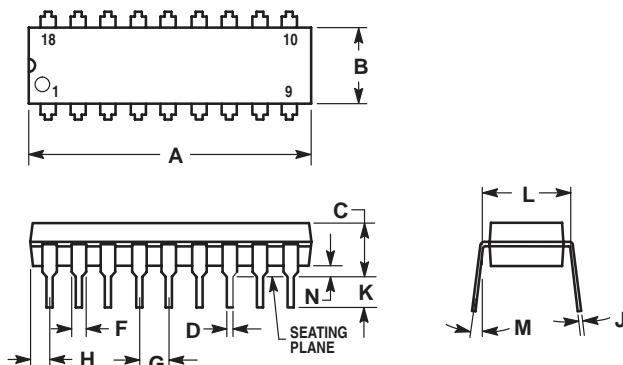
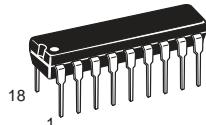
1. LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	31.50	32.13	1.240	1.265
B	13.21	13.72	0.520	0.540
C	4.70	5.21	0.185	0.205
D	0.38	0.51	0.015	0.020
F	1.02	1.52	0.040	0.060
G	2.54 BSC		0.100 BSC	
H	1.65	2.16	0.065	0.085
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	14.99	15.49	0.590	0.610
M	—	10	—	10°
N	0.51	1.02	0.020	0.040
P	0.13	0.38	0.005	0.015
Q	0.51	0.76	0.020	0.030

A, B, N, P SUFFIX**CASE 707-02**

Plastic Package

ISSUE C



NOTES:

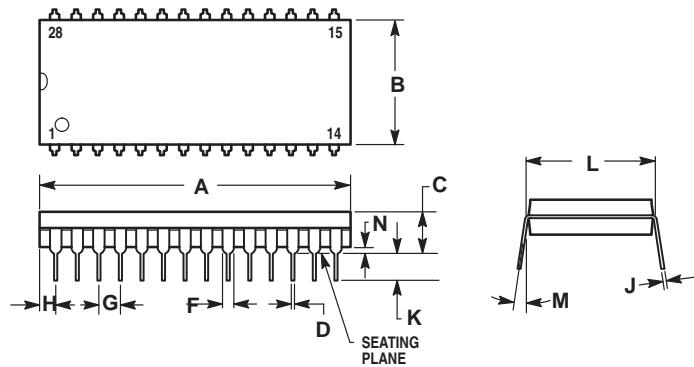
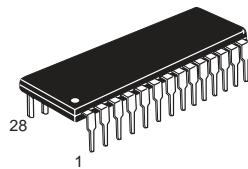
1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	22.22	23.24	0.875	0.915
B	6.10	6.60	0.240	0.260
C	3.56	4.57	0.140	0.180
D	0.36	0.56	0.014	0.022
F	1.27	1.78	0.050	0.070
G	2.54 BSC		0.100 BSC	
H	1.02	1.52	0.040	0.060
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	0°	15°	0°	15°
N	0.51	1.02	0.020	0.040

P SUFFIX**CASE 710-02**

Plastic Package

ISSUE B



NOTES:

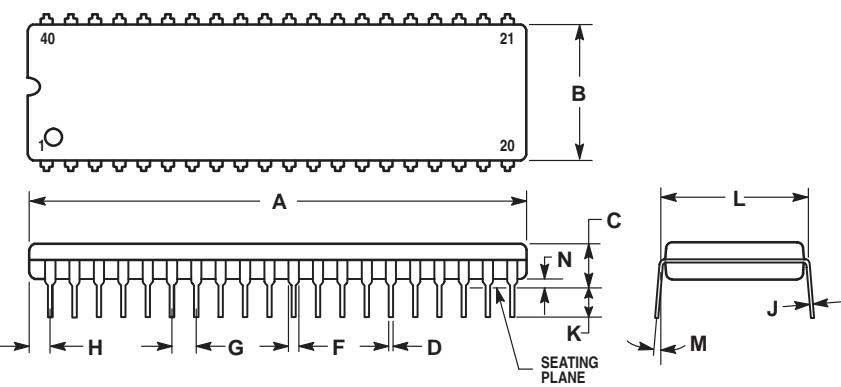
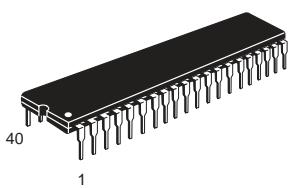
1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	36.45	37.21	1.435	1.465
B	13.72	14.22	0.540	0.560
C	3.94	5.08	0.155	0.200
D	0.36	0.56	0.014	0.022
F	1.02	1.52	0.040	0.060
G	2.54 BSC		0.100 BSC	
H	1.65	2.16	0.065	0.085
J	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
L	15.24 BSC		0.600 BSC	
M	0°	15°	0°	15°
N	0.51	1.02	0.020	0.040

P SUFFIX**CASE 711-03**

Plastic Package

ISSUE C



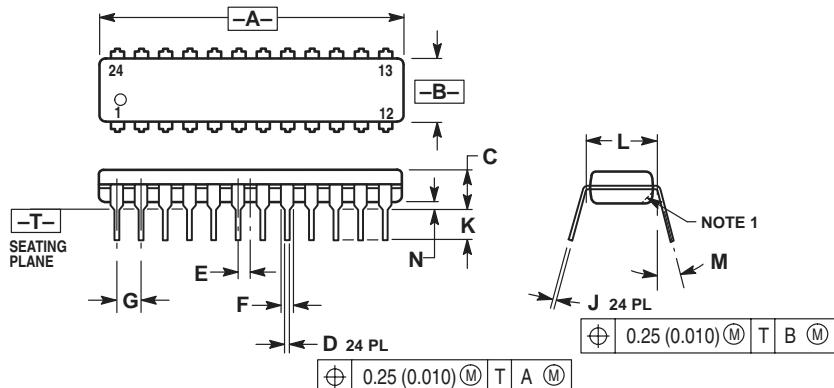
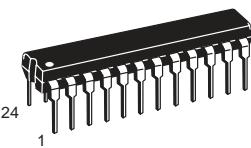
NOTES:

1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

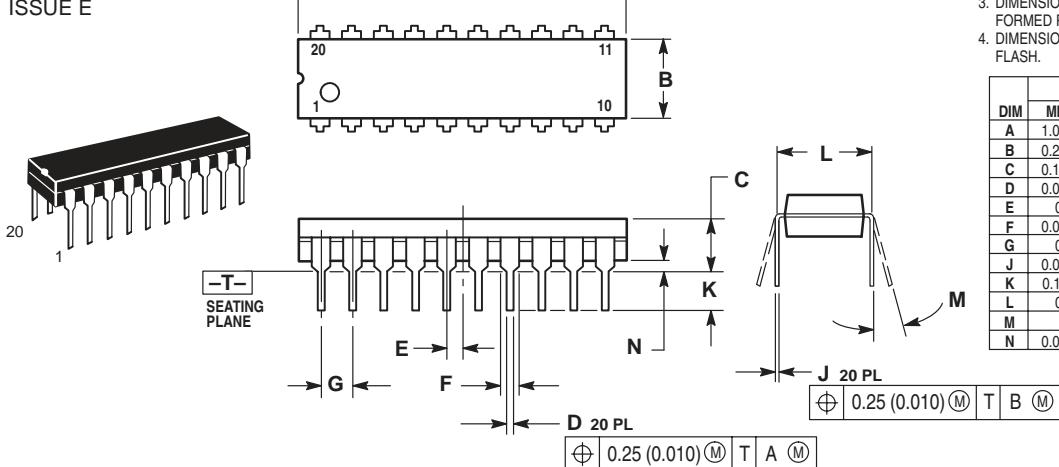
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	51.69	52.45	2.035	2.065
B	13.72	14.22	0.540	0.560
C	3.94	5.08	0.155	0.200
D	0.36	0.56	0.014	0.022
F	1.02	1.52	0.040	0.060
G	2.54 BSC		0.100 BSC	
H	1.65	2.16	0.065	0.085
J	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
L	15.24 BSC		0.600 BSC	
M	0°	15°	0°	15°
N	0.51	1.02	0.020	0.040

F, P, P-3 SUFFIX**CASE 724-03**

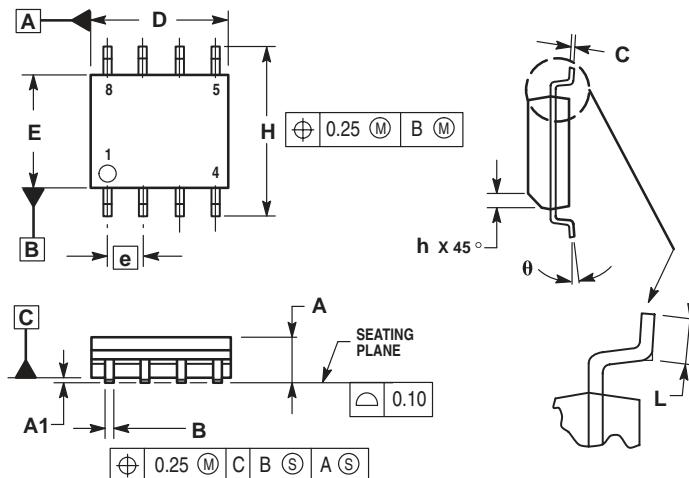
Plastic Package
(NDIP-24)
ISSUE D

**H, P, DP SUFFIX****CASE 738-03**

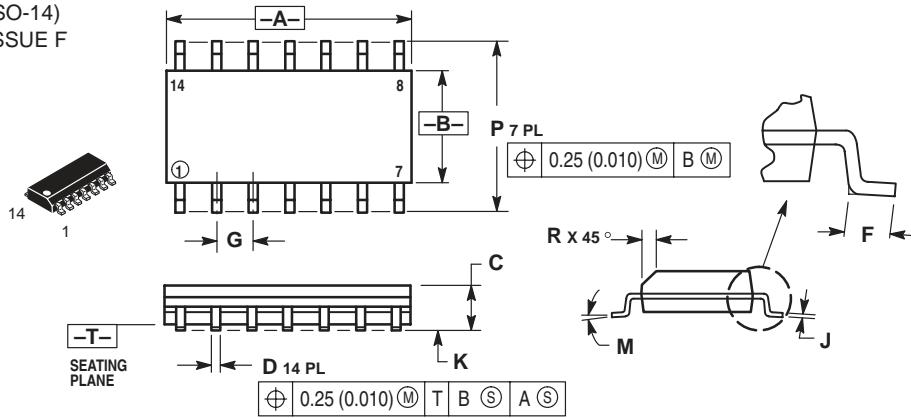
Plastic Package
ISSUE E

**D, D1, D2 SUFFIX****CASE 751-05**

Plastic Package
(SO-8, SOP-8)
ISSUE R



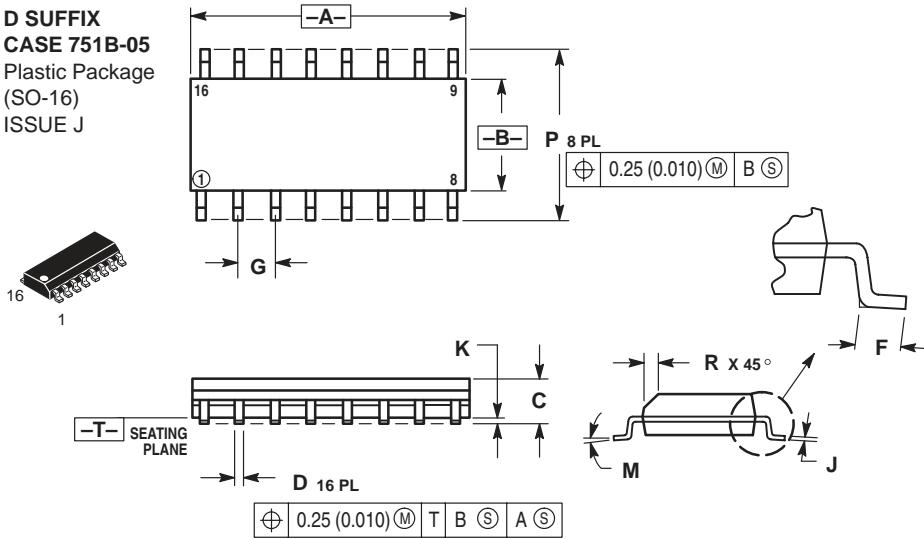
D SUFFIX
CASE 751A-03
 Plastic Package
 (SO-14)
 ISSUE F



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

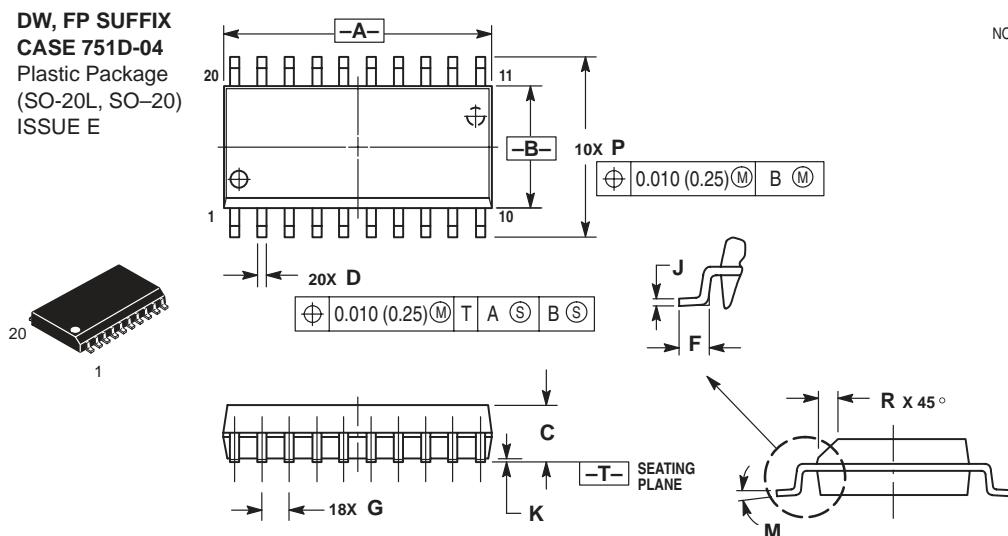
D SUFFIX
CASE 751B-05
 Plastic Package
 (SO-16)
 ISSUE J



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

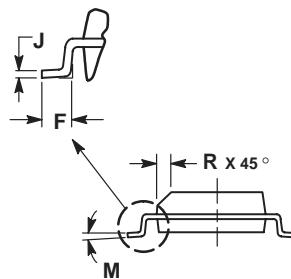
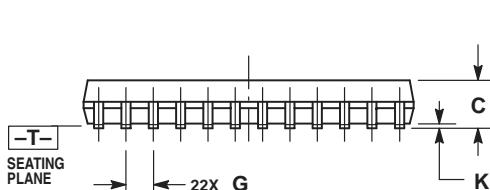
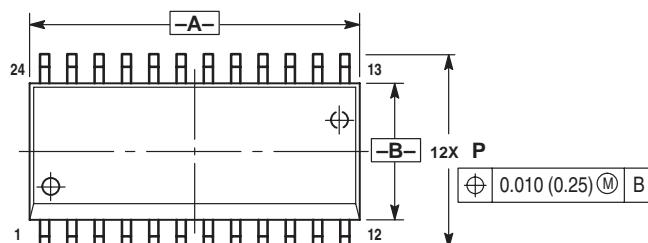
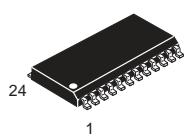
DW, FP SUFFIX
CASE 751D-04
 Plastic Package
 (SO-20L, SO-20)
 ISSUE E



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.150 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DW SUFFIX
CASE 751E-04
 Plastic Package
 (SO-24L,
 SOP (16+4+4)L)
 ISSUE E

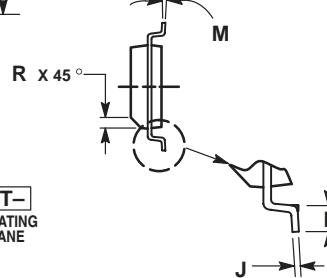
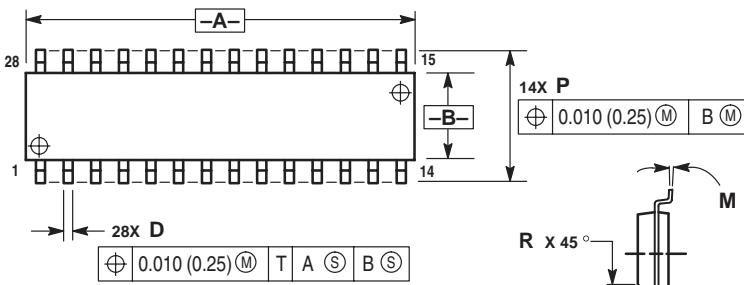
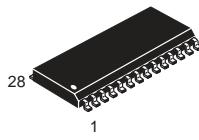


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	15.25	15.54	0.601	0.612
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.41	0.90	0.016	0.035
G	1.27 BSC		0.050 BSC	
J	0.23	0.32	0.009	0.013
K	0.13	0.29	0.005	0.011
M	0°	8°	0°	8°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

DW SUFFIX
CASE 751F-04
 Plastic Package
 (SO-28L, SOIC-28)
 ISSUE E

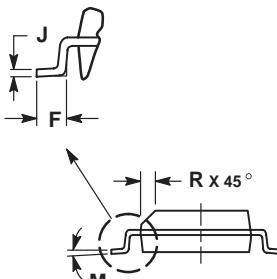
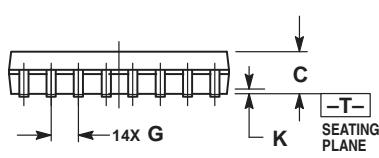
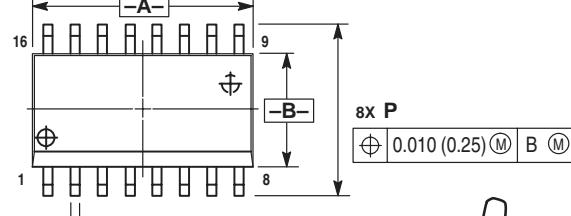
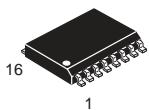


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	17.80	18.05	0.701	0.711
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.41	0.90	0.016	0.035
G	1.27 BSC		0.050 BSC	
J	0.23	0.32	0.009	0.013
K	0.13	0.29	0.005	0.011
M	0°	8°	0°	8°
P	10.01	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

DW SUFFIX
CASE 751G-02
 Plastic Package
 (SO-16L, SOP-16L,
 SOP-8+8L)
 ISSUE A

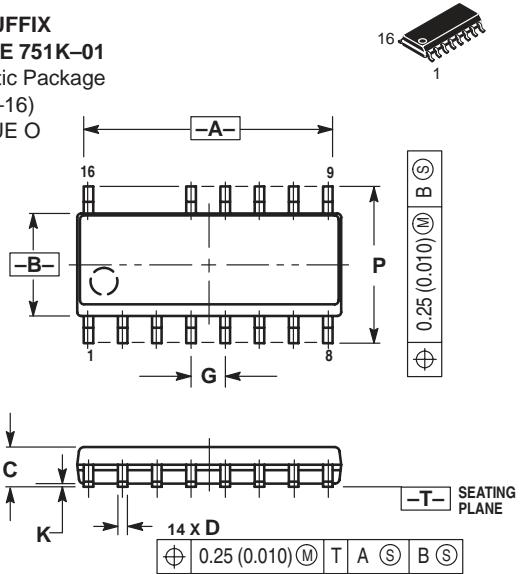


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.15	10.45	0.400	0.411
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050 BSC	
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

D SUFFIX
CASE 751K-01
Plastic Package
(SO-16)
ISSUE O

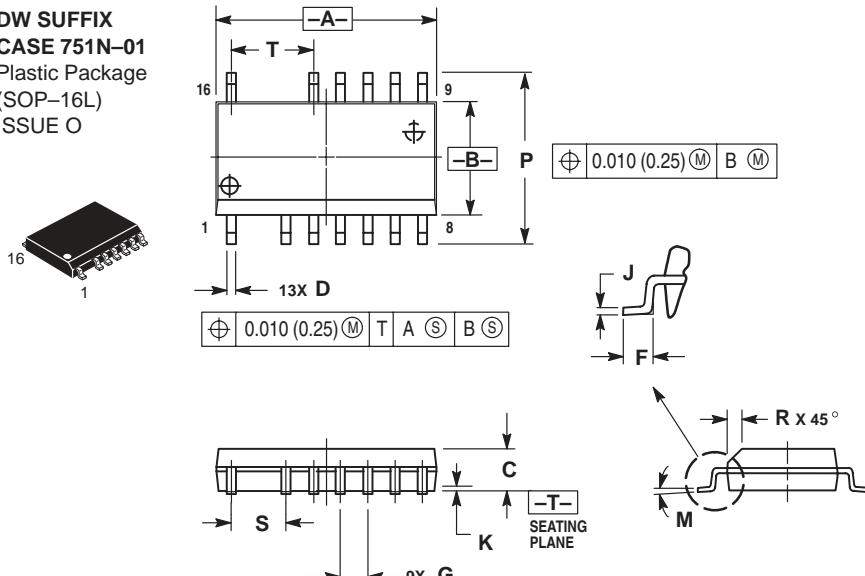


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.388	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

DW SUFFIX
CASE 751N-01
Plastic Package
(SOP-16L)
ISSUE O

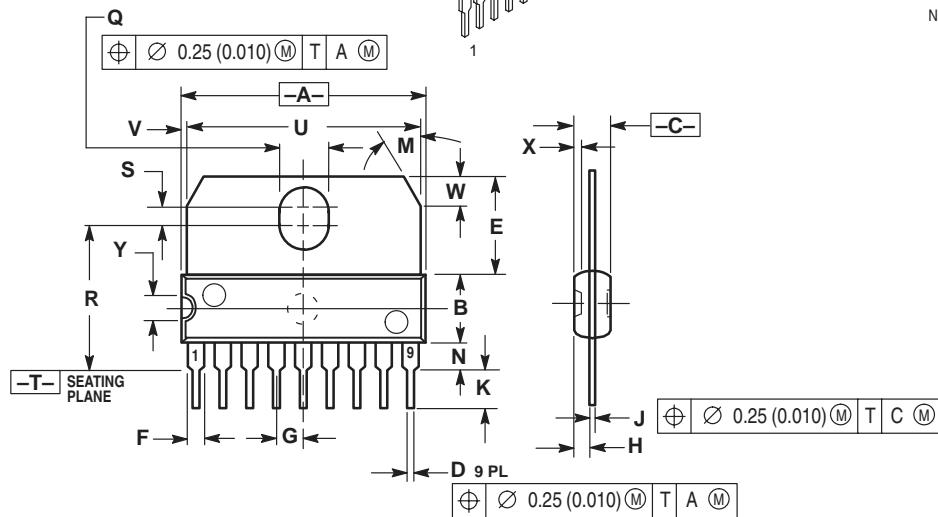
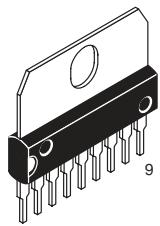


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.15	10.45	0.400	0.411
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050 BSC	
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029
S	2.54 BSC		0.100 BSC	
T	3.81 BSC		0.150 BSC	

CASE 762-01

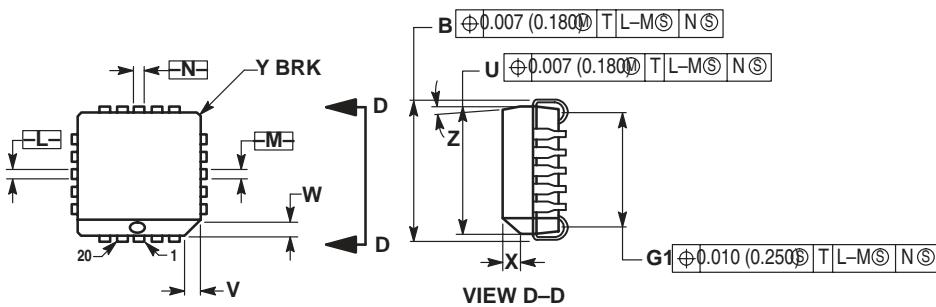
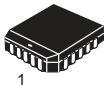
 Plastic Medium Power Package
 (SIP-9)
 ISSUE C


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.

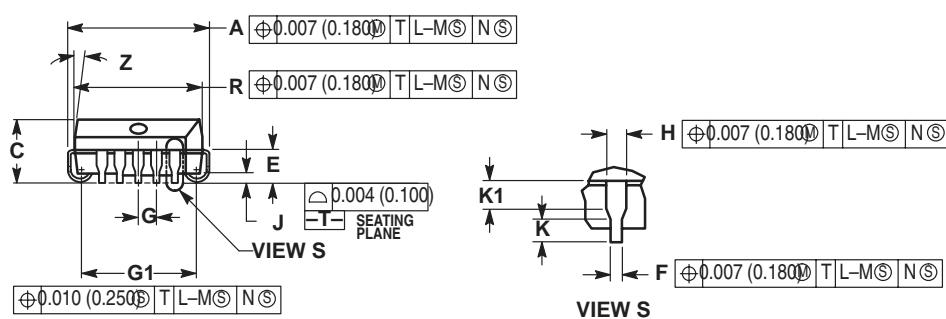
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	22.40	23.00	0.873	0.897
B	6.40	6.60	0.252	0.260
C	3.45	3.65	0.135	0.143
D	0.40	0.55	0.015	0.021
E	9.35	9.60	0.368	0.377
F	1.40	1.60	0.055	0.062
G	2.54 BSC		0.100 BSC	
H	1.51	1.71	0.059	0.067
J	0.360	0.400	0.014	0.015
K	3.95	4.20	0.155	0.165
L	30 °BSC		30 °BSC	
M	2.50	2.70	0.099	0.106
N	3.15	3.45	0.124	0.135
R	13.60	13.90	0.535	0.547
S	1.65	1.95	0.064	0.076
U	22.00	22.20	0.866	0.874
V	0.55	0.75	0.021	0.029
W	2.89 BSC		0.113 BSC	
X	0.65	0.75	0.025	0.029
Y	2.70	2.80	0.106	0.110

FN SUFFIX
CASE 775-02

 Plastic Package
 (PLCC-20)
 ISSUE C


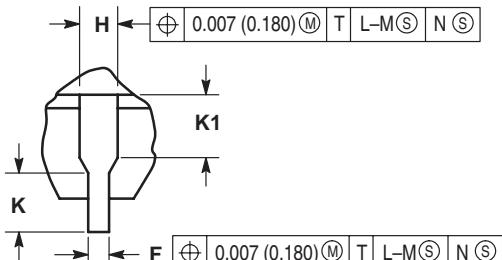
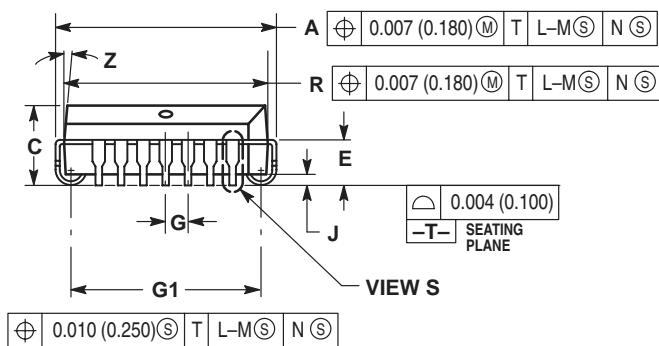
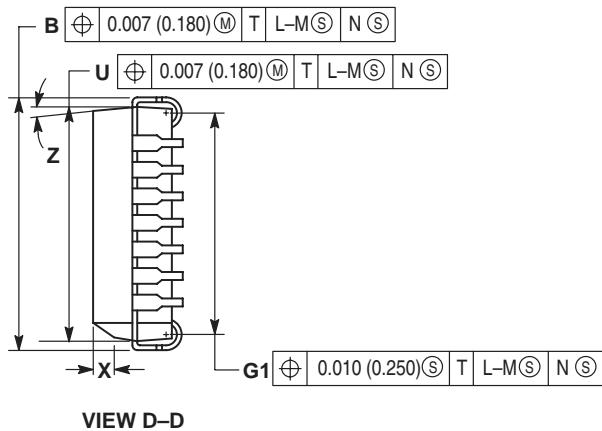
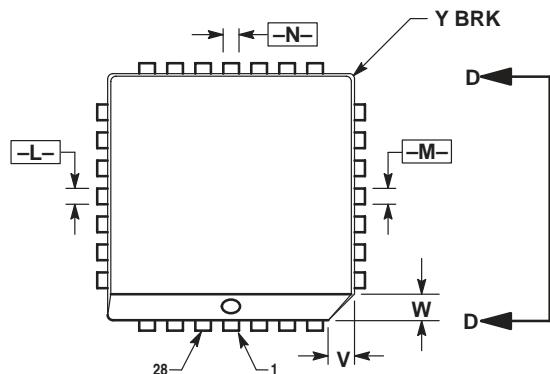
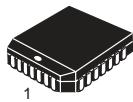
NOTES:

1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1982.
5. CONTROLLING DIMENSION: INCH.
6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2 °	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040	—	1.02	—

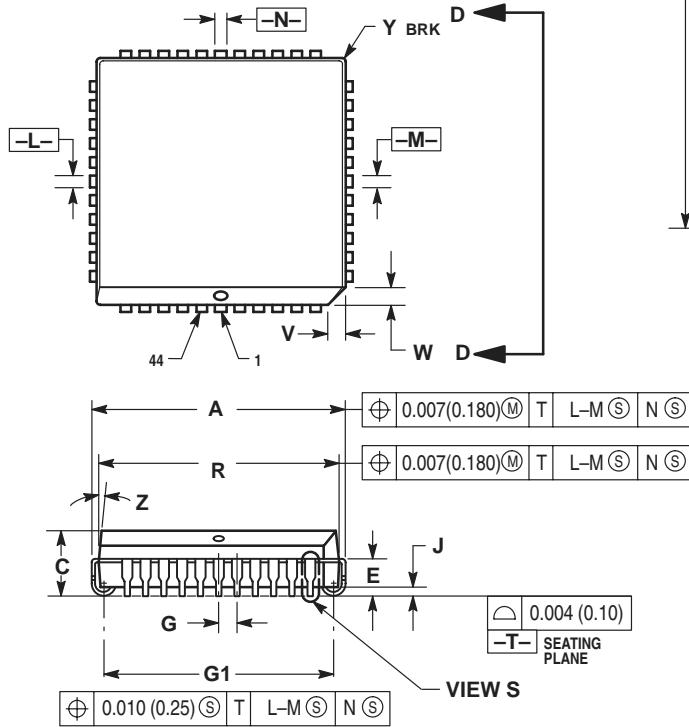
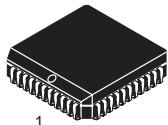
FN SUFFIX
CASE 776-02
Plastic Package
(PLCC-28)
ISSUE D



- NOTES:**
1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
 2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
 4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 5. CONTROLLING DIMENSION: INCH.
 6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
 7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040	—	1.02	—

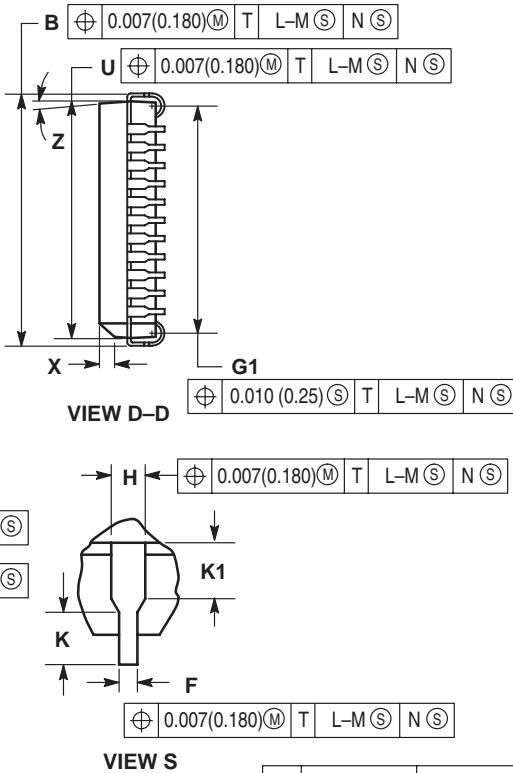
FN SUFFIX
CASE 777-02
Plastic Package
(PLCC)
ISSUE C



NOTES:

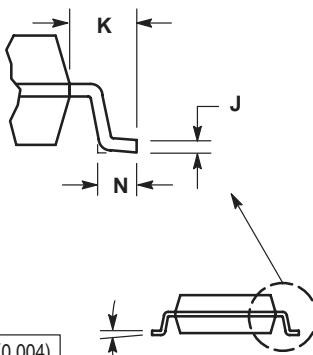
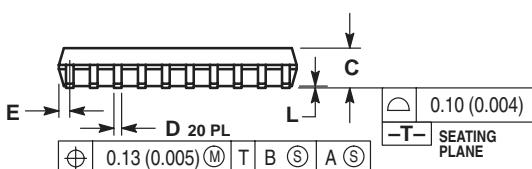
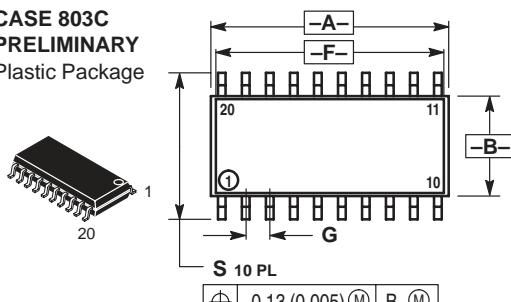
- DATUMS -L-, -M-, AND -N- ARE DETERMINED WHERE TOP OF LEAD SHOULDER EXISTS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.25) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.

- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.685	0.695	17.40	17.65
B	0.685	0.695	17.40	17.65
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.650	0.656	16.51	16.66
U	0.650	0.656	16.51	16.66
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.610	0.630	15.50	16.00
K1	0.040	—	1.02	—

M SUFFIX
CASE 803C
PRELIMINARY
Plastic Package

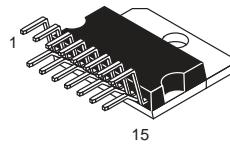


- NOTES:
- CONTROLLING DIMENSION: MILLIMETER.
 - DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 - MAXIMUM MOLD PROTRUSION 0.15 (0.008) PER SIDE.
 - DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.006) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

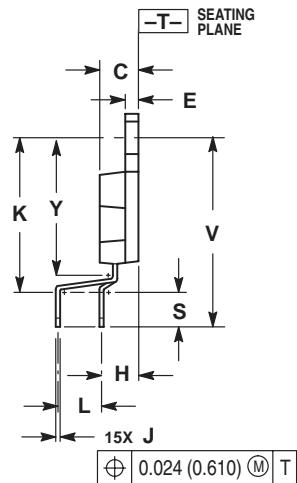
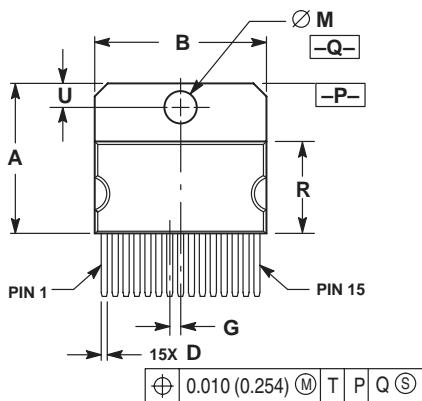
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.35	12.80	0.486	0.504
B	5.10	5.45	0.201	0.215
C	1.95	2.05	0.077	0.081
D	0.35	0.50	0.014	0.020
E	—	0.81	—	0.032
F	12.40*	—	0.488*	—
G	1.15	1.39	0.045	0.055
H	0.59	0.81	0.023	0.032
J	0.18	0.27	0.007	0.011
K	1.10	1.50	0.043	0.059
L	0.05	0.20	0.001	0.008
M	0°	10°	0°	10°
N	0.50	0.85	0.020	0.033
S	7.40	8.20	0.291	0.323

*APPROXIMATE

TV SUFFIX
CASE 821C-04
 Plastic Package
 (15-Pin ZIP)
 ISSUE D



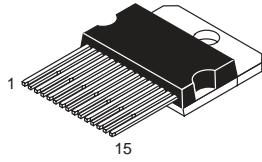
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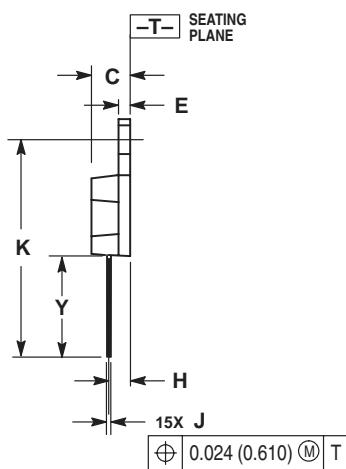
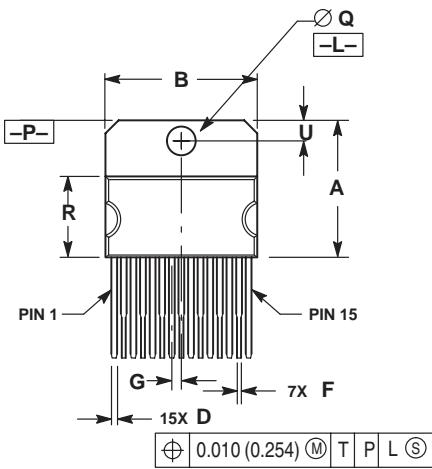
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION R DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
 5. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 (0.250).
 6. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.003 (0.076) TOTAL IN EXCESS OF THE D DIMENSION, AT MAXIMUM MATERIAL CONDITION.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.684	0.694	17.374	17.627
B	0.784	0.792	19.914	20.116
C	0.173	0.181	4.395	4.597
D	0.024	0.031	0.610	0.787
E	0.058	0.062	1.473	1.574
G	0.050 BSC		1.270 BSC	
H	0.169 BSC		4.293 BSC	
J	0.018	0.024	0.458	0.609
K	0.700	0.710	17.780	18.034
L	0.200 BSC		5.080 BSC	
M	0.148	0.151	3.760	3.835
R	0.416	0.426	10.567	10.820
S	0.157	0.167	3.988	4.242
U	0.105	0.115	2.667	2.921
V	0.668 REF		22.047 REF	
Y	0.625	0.639	15.875	16.231

T SUFFIX
CASE 821D-03
 Plastic Package
 ISSUE C



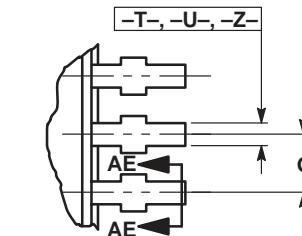
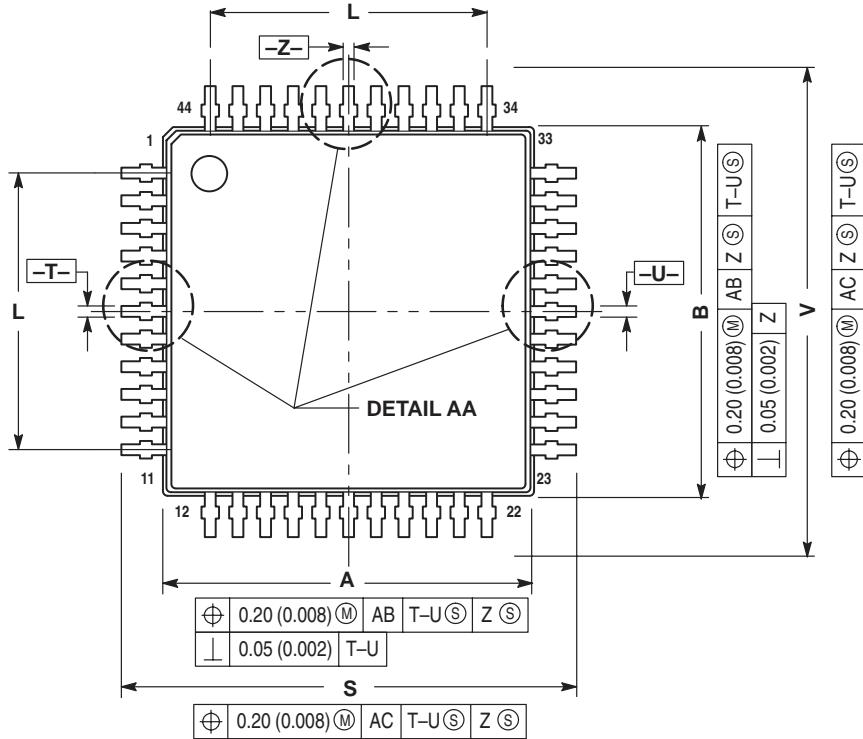
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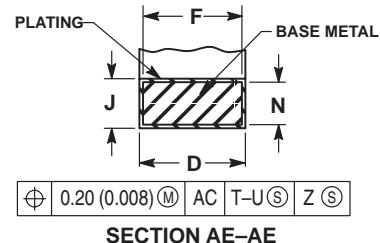
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION R DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
 5. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 (0.250).
 6. DELETED
 7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.003 (0.076) TOTAL IN EXCESS OF THE D DIMENSION, AT MAXIMUM MATERIAL CONDITION.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.681	0.694	17.298	17.627
B	0.784	0.792	19.914	20.116
C	0.173	0.181	4.395	4.597
D	0.024	0.031	0.610	0.787
E	0.058	0.062	1.473	1.574
F	0.016	0.023	0.407	0.584
G	0.050 BSC		1.270 BSC	
H	0.110 BSC		2.794 BSC	
J	0.018	0.024	0.458	0.609
K	1.078	1.086	27.382	27.584
Q	0.148	0.151	3.760	3.835
R	0.416	0.426	10.567	10.820
U	0.110 BSC		2.794 BSC	
Y	0.503 REF		12.776 REF	

FTB SUFFIX
CASE 824D-01
Plastic Package
(TQFP-44)
ISSUE O



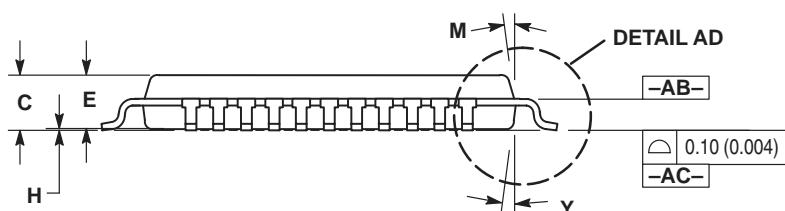
DETAIL AA



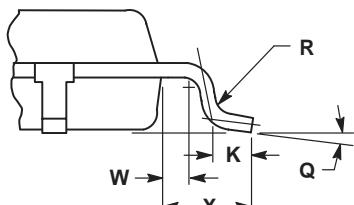
SECTION AE-AE

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
4. DATUMS -T-, -U- AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.
5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -AC-.
6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.530 (0.021).



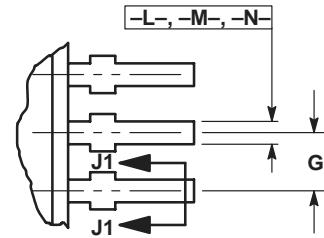
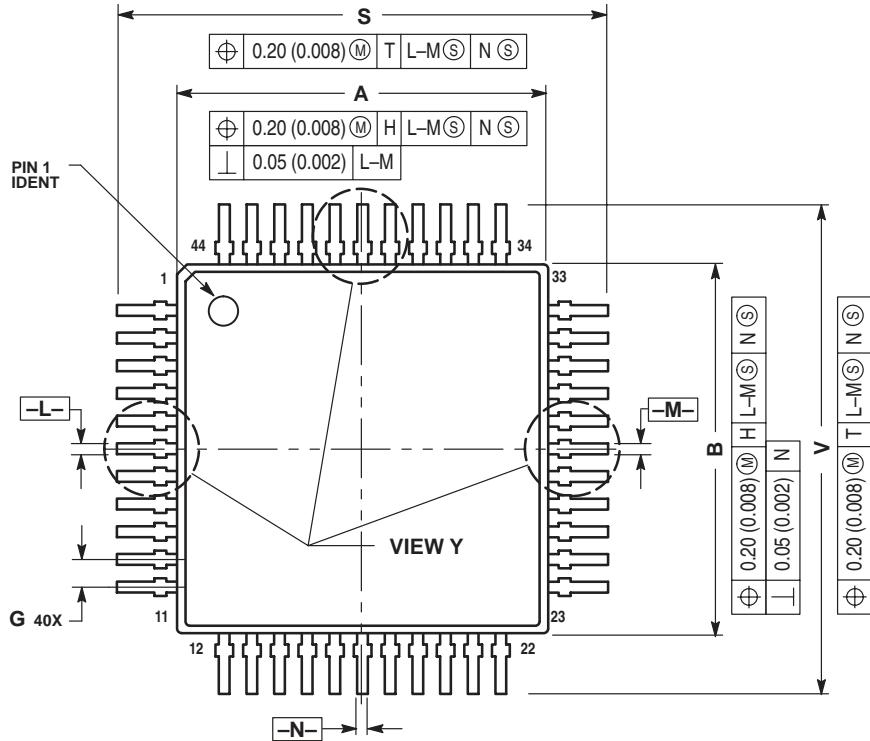
DETAIL AD



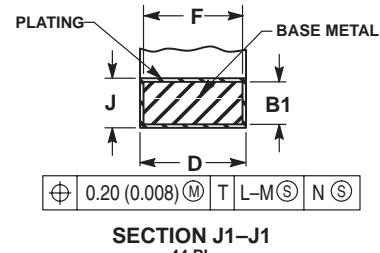
VIEW AD

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.950	10.050	0.392	0.396
B	9.950	10.050	0.392	0.396
C	1.400	1.600	0.055	0.063
D	0.300	0.450	0.012	0.018
E	1.350	1.450	0.053	0.057
F	0.300	0.400	0.012	0.016
G	0.800 BSC		0.031 BSC	
H	0.050	0.150	0.002	0.006
J	0.090	0.200	0.004	0.008
K	0.450	0.550	0.018	0.022
L	8.000 BSC		0.315 BSC	
M	12° REF		12° REF	
N	0.090	0.160	0.004	0.006
Q	1°	5°	1°	5°
R	0.100	0.200	0.004	0.008
S	11.900	12.100	0.469	0.476
V	11.900	12.100	0.469	0.476
W	0.200 REF		0.008 REF	
X	1.000 REF		0.039 REF	
Y	12° REF		12° REF	

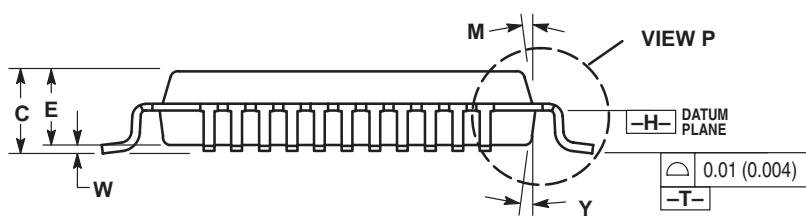
FB SUFFIX
CASE 824E-02
Plastic Package
(QFP)
ISSUE A



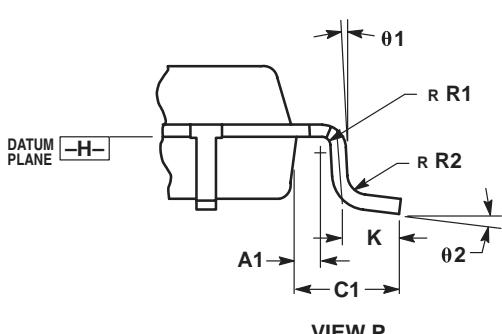
VIEW Y
3 PL



SECTION J1-J1
44 PL

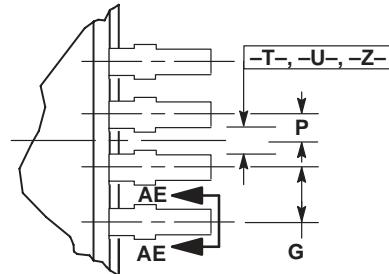
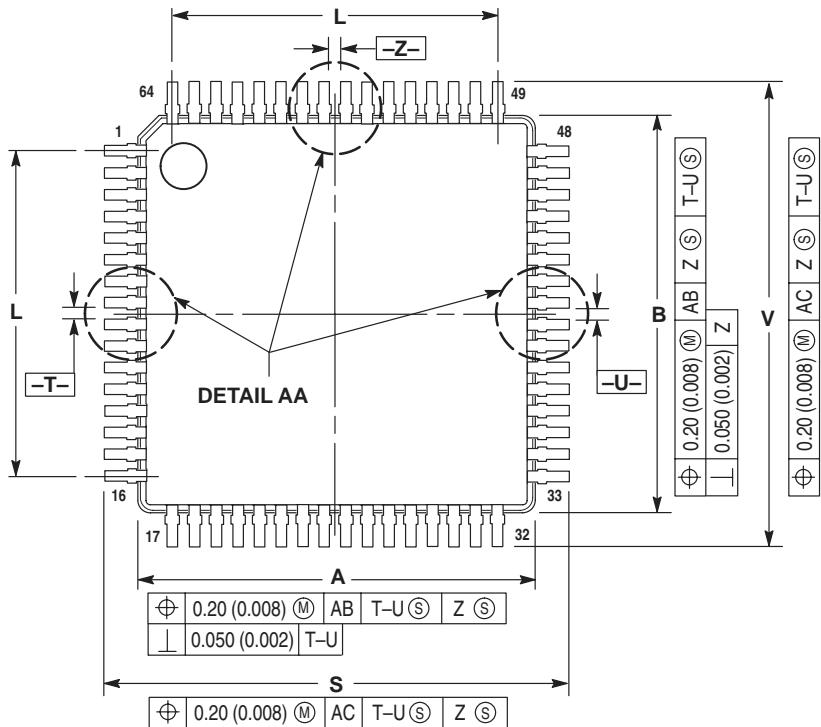
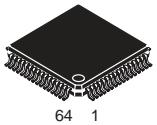


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
 4. DATUMS -L-, -M- AND -N- TO BE DETERMINED AT DATUM PLANE -H-.
 5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -T-.
 6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
 7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.530 (0.021).

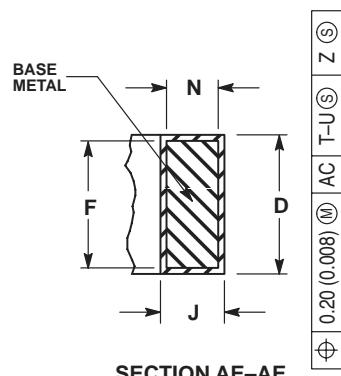


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.90	10.10	0.390	0.398
B	9.90	10.10	0.390	0.398
C	2.00	2.21	0.079	0.087
D	0.30	0.45	0.0118	0.0177
E	2.00	2.10	0.079	0.083
F	0.30	0.40	0.012	0.016
G	0.80	BSC	0.031	BSC
J	0.13	0.23	0.005	0.009
K	0.65	0.95	0.026	0.037
M	5°	10°	5°	10°
S	12.95	13.45	0.510	0.530
V	12.95	13.45	0.510	0.530
W	0.000	0.210	0.000	0.008
Y	5°	10°	5°	10°
A1	0.450	REF	0.018	REF
B1	0.130	0.170	0.005	0.007
C1	1.600	REF	0.063	REF
R1	0.130	0.300	0.005	0.012
R2	0.130	0.300	0.005	0.012
θ1	5°	10°	5°	10°
θ2	0°	7°	0°	7°

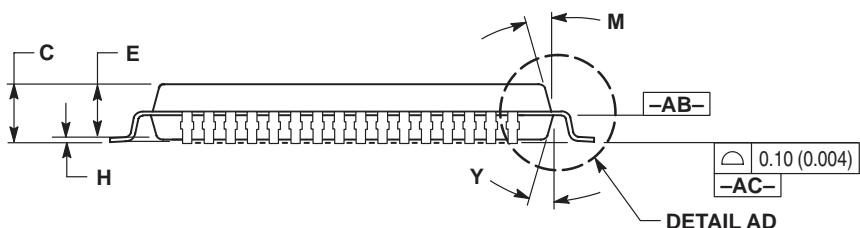
FB SUFFIX
CASE 840F-01
Plastic Package
ISSUE O



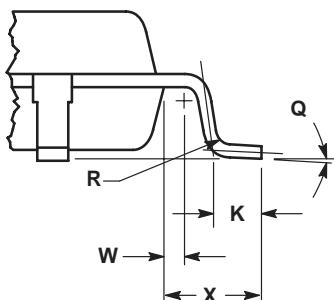
DETAIL AA



SECTION AE-AE



DETAIL AD



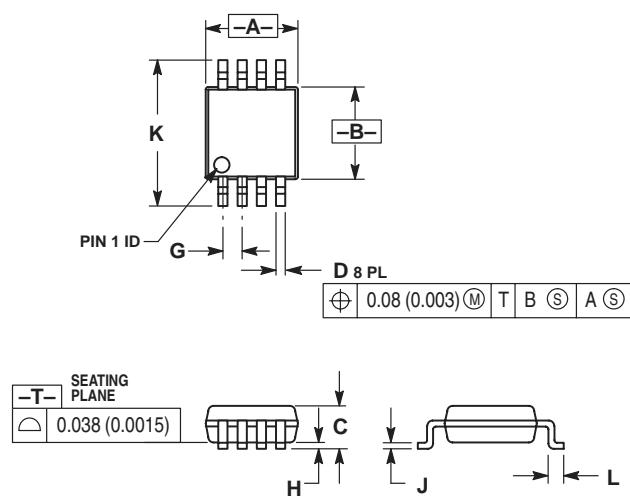
DETAIL AD

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
4. DATUMS -T-, -U- AND -Z- TO BE DETERMINED AT DATUM PLANE -AC-.
5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -AC-.
6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.350 (0.014).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.950	10.050	0.392	0.396
B	9.950	10.050	0.392	0.396
C	1.400	1.600	0.055	0.063
D	0.170	0.270	0.007	0.011
E	1.350	1.450	0.053	0.057
F	0.170	0.230	0.007	0.009
G	0.500 BSC		0.020 BSC	
H	0.050	0.150	0.002	0.006
J	0.090	0.200	0.004	0.008
K	0.450	0.550	0.018	0.022
L	7.500 BSC		0.295 BSC	
M	12° REF		12° REF	
N	0.090	0.160	0.004	0.006
P	0.250 BSC		0.010 BSC	
Q	1°	5°	1°	5°
R	0.100	0.200	0.004	0.008
S	11.900	12.100	0.469	0.476
V	11.900	12.100	0.469	0.476
W	0.200 REF		0.008 REF	
X	1.000 REF		0.039 REF	
Y	12° REF		12° REF	

DM SUFFIX
CASE 846A-02
 Plastic Package
 (Micro-8)
 ISSUE C

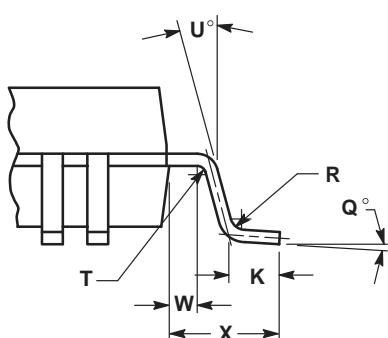
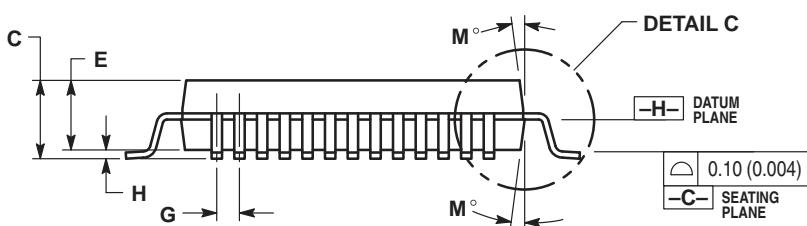
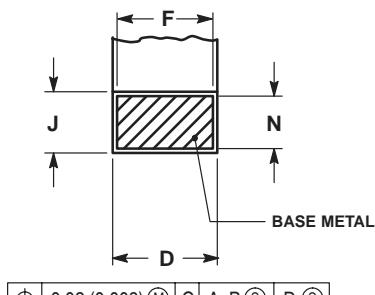
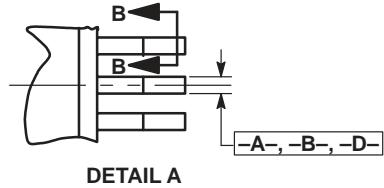
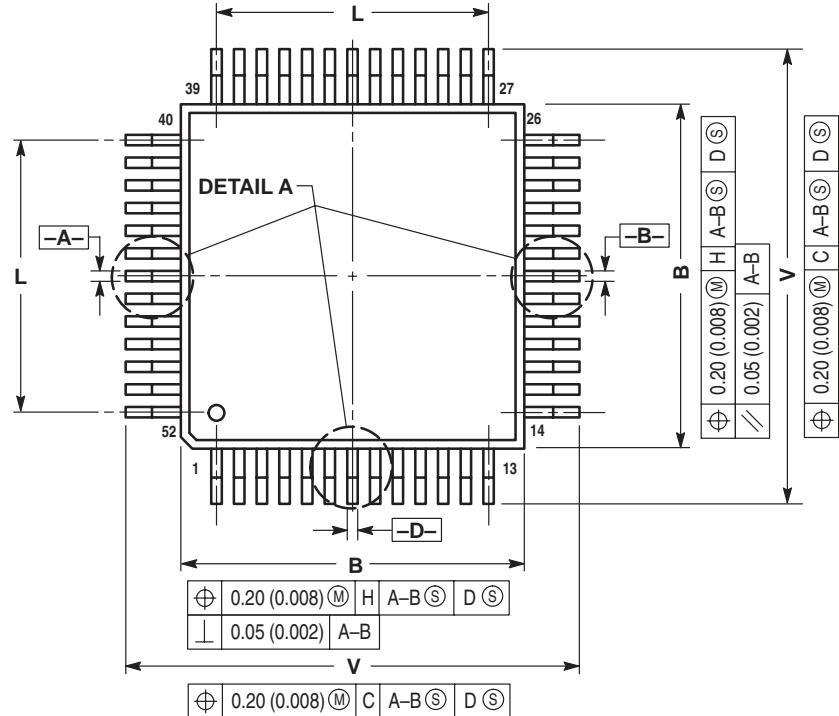
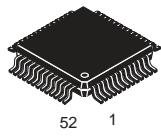


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.90	3.10	0.114	0.122
B	2.90	3.10	0.114	0.122
C	—	1.10	—	0.043
D	0.25	0.40	0.010	0.016
G	0.65 BSC		0.026 BSC	
H	0.05	0.15	0.002	0.006
J	0.13	0.23	0.005	0.009
K	4.75	5.05	0.187	0.199
L	0.40	0.70	0.016	0.028

FB SUFFIX
CASE 848B-04
Plastic Package
(TQFP-52)
ISSUE C



DETAIL C

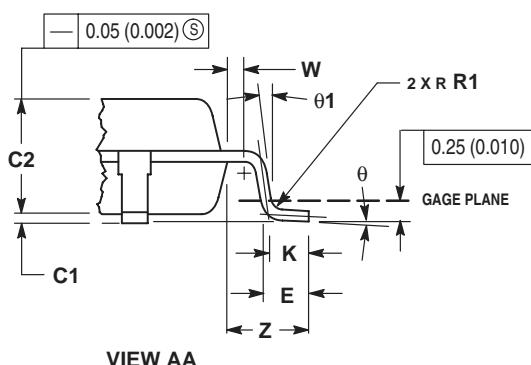
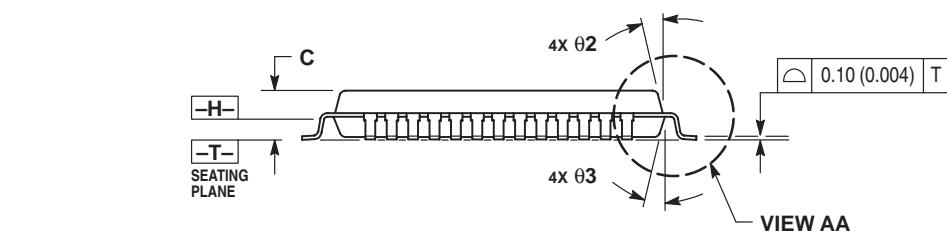
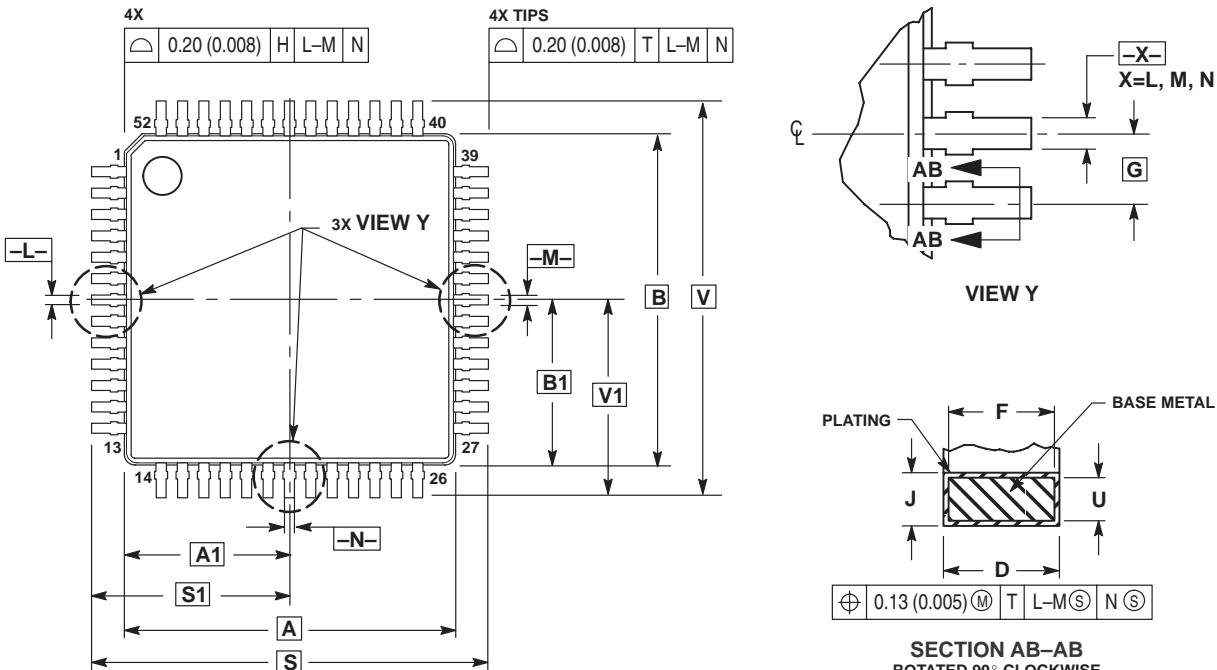
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
 4. DATUMS -A-, -B- AND -D- TO BE DETERMINED AT DATUM PLANE -H-.
 5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -C-.
 6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
 7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.90	10.10	0.390	0.398
B	9.90	10.10	0.390	0.398
C	2.10	2.45	0.083	0.098
D	0.22	0.38	0.009	0.015
E	2.00	2.10	0.079	0.083
F	0.22	0.33	0.009	0.013
G	0.65	BSC	0.026	BSC
H	—	0.25	—	0.010
J	0.13	0.23	0.005	0.009
K	0.65	0.95	0.026	0.037
L	7.80	REF	0.307	REF
M	5°	10°	5°	10°
N	0.13	0.17	0.005	0.007
Q	0°	7°	0°	7°
R	0.13	0.30	0.005	0.012
S	12.95	13.45	0.510	0.530
T	0.13	—	0.005	—
U	0°	—	0°	—
V	12.95	13.45	0.510	0.530
W	0.35	0.45	0.014	0.018
X	1.6	REF	0.063	REF

**FB SUFFIX
CASE 848D-03
Plastic Package
ISSUE C**



52 1

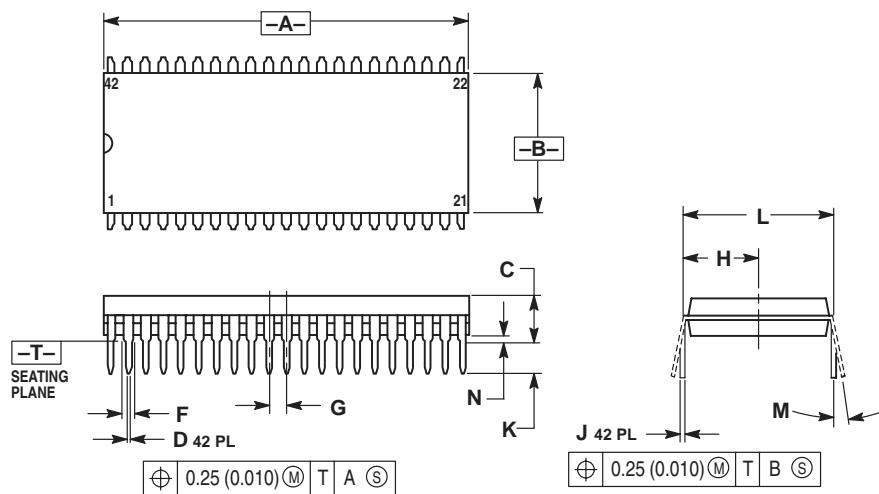
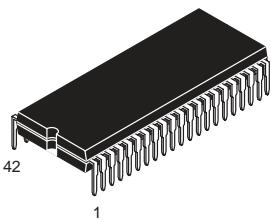


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
 4. DATUMS -L-, -M- AND -N- TO BE DETERMINED AT DATUM PLANE -H-.
 5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -T-.
 6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
 7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.46 (0.018). MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD OR PROTRUSION 0.07 (0.003).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.00	BSC	0.394	BSC
A1	5.00	BSC	0.197	BSC
B	10.00	BSC	0.394	BSC
B1	5.00	BSC	0.197	BSC
C	—	1.70	—	0.067
C1	0.05	0.20	0.002	0.008
C2	1.30	1.50	0.051	0.059
D	0.20	0.40	0.008	0.016
E	0.45	0.75	0.018	0.030
F	0.22	0.35	0.009	0.014
G	0.65	BSC	0.026	BSC
J	0.07	0.20	0.003	0.008
K	0.50	REF	0.020	REF
R1	0.08	0.20	0.003	0.008
S	12.00	BSC	0.472	BSC
S1	6.00	BSC	0.236	BSC
U	0.09	0.16	0.004	0.006
V	12.00	BSC	0.472	BSC
V1	6.00	BSC	0.236	BSC
W	0.20	REF	0.008	REF
Z	1.00	REF	0.039	REF
θ	0°	7°	0°	7°
Ø1	0°	—	0°	—
Ø2	12°	REF	12°	REF
Ø3	5°	13°	5°	13°

B SUFFIX
CASE 858-01
Plastic Package
ISSUE O

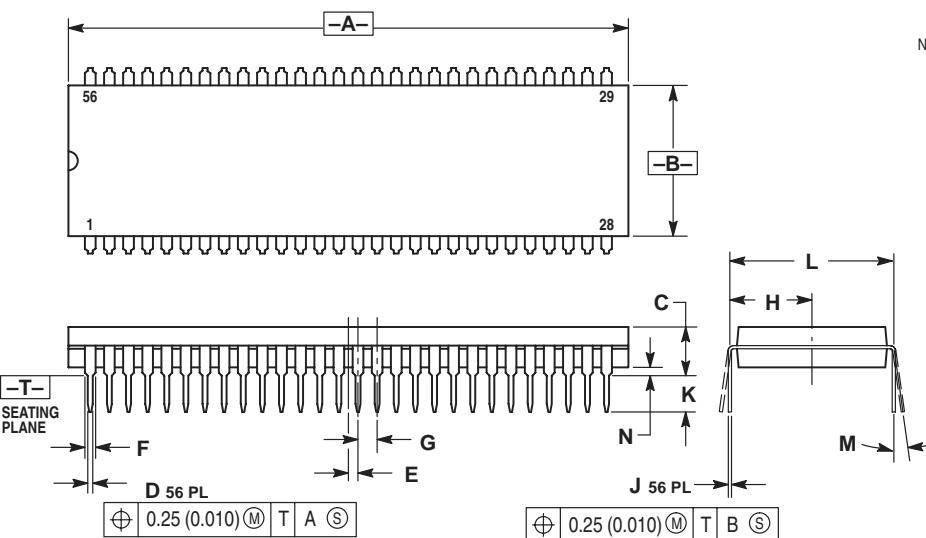
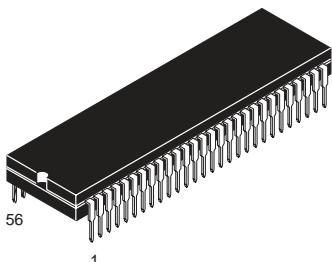


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH. MAXIMUM MOLD FLASH 0.25 (0.010).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.435	1.465	36.45	37.21
B	0.540	0.560	13.72	14.22
C	0.155	0.200	3.94	5.08
D	0.014	0.022	0.36	0.56
F	0.032	0.046	0.81	1.17
G	0.070 BSC		1.778 BSC	
H	0.300 BSC		7.62 BSC	
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.600 BSC		15.24 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.02

B SUFFIX
CASE 859-01
Plastic Package
(SDIP)
ISSUE O



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH. MAXIMUM MOLD FLASH 0.25 (0.010).

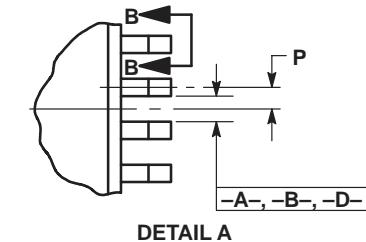
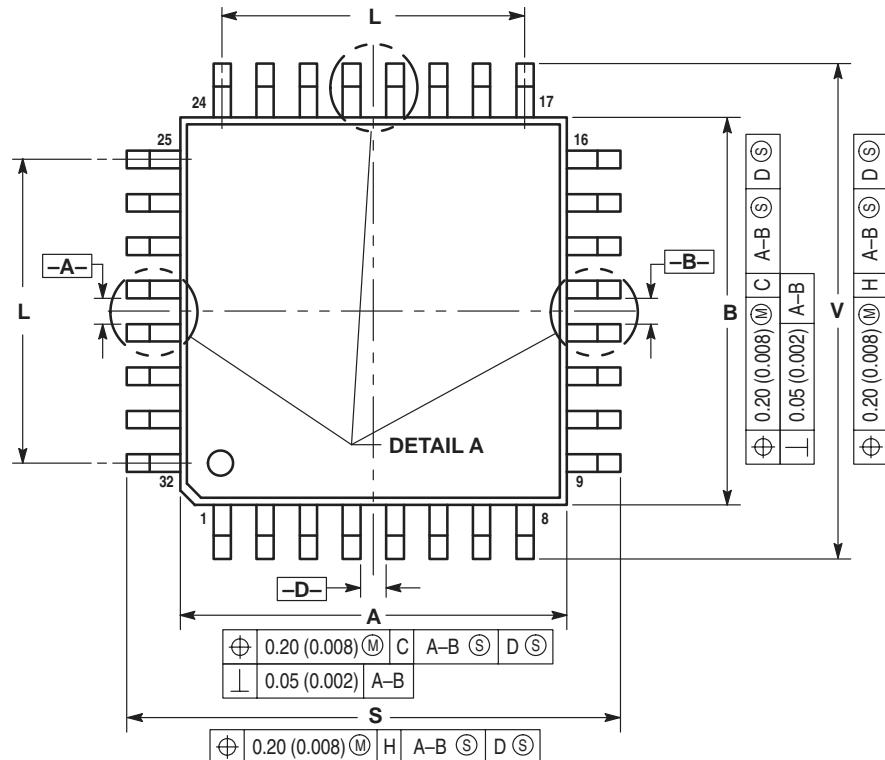
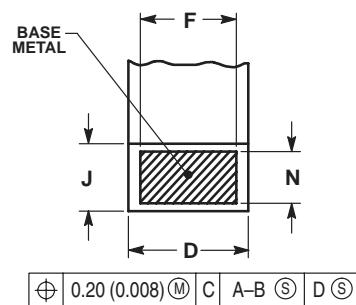
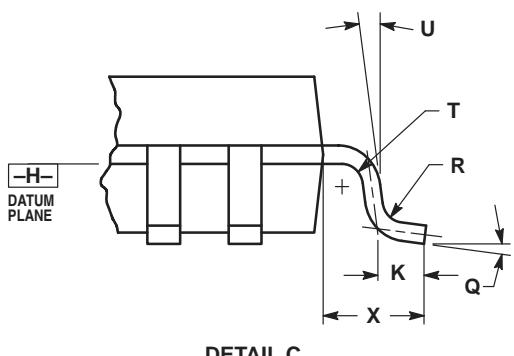
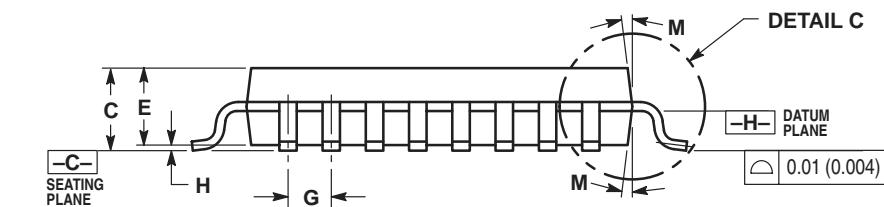
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	2.035	2.065	51.69	52.45
B	0.540	0.560	13.72	14.22
C	0.155	0.200	3.94	5.08
D	0.014	0.022	0.36	0.56
E	0.035 BSC		0.89 BSC	
F	0.032	0.046	0.81	1.17
G	0.070 BSC		1.778 BSC	
H	0.300 BSC		7.62 BSC	
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.600 BSC		15.24 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.02

FB, FTB SUFFIX
CASE 873-01

Plastic Package

(TQFP-32)

ISSUE A

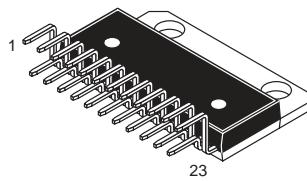

DETAIL A

SECTION B-B
VIEW ROTATED 90° CLOCKWISE

DETAIL C

NOTES:

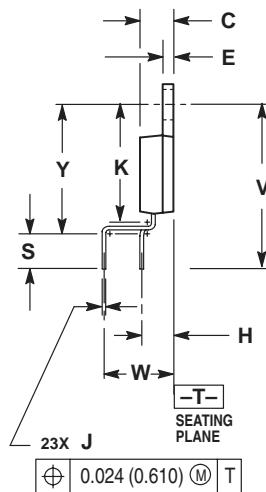
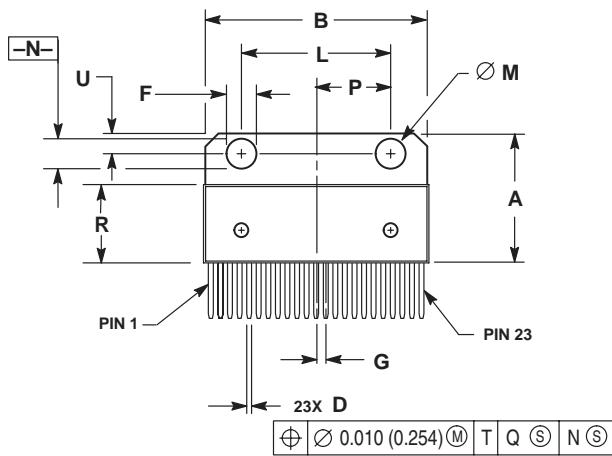
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
4. DATUMS -A-, -B- AND -D- TO BE DETERMINED AT DATUM PLANE -H-.
5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -C-.
6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.95	7.10	0.274	0.280
B	6.95	7.10	0.274	0.280
C	1.40	1.60	0.055	0.063
D	0.273	0.373	0.010	0.015
E	1.30	1.50	0.051	0.059
F	0.273	—	0.010	—
G	0.80 BSC	—	0.031 BSC	—
H	—	0.20	—	0.008
J	0.119	0.197	0.005	0.008
K	0.33	0.57	0.013	0.022
L	5.6 REF	—	0.220 REF	—
M	6°	8°	6°	8°
N	0.119	0.135	0.005	0.005
P	0.40 BSC	—	0.016 BSC	—
Q	5°	10°	5°	10°
R	0.15	0.25	0.006	0.010
S	8.85	9.15	0.348	0.360
T	0.15	0.25	0.006	0.010
U	5°	11°	5°	11°
V	8.85	9.15	0.348	0.360
X	1.00 REF	—	0.039 REF	—

T SUFFIX
CASE 894-03
Plastic Package
(23-Pin SZIP)
ISSUE B



23

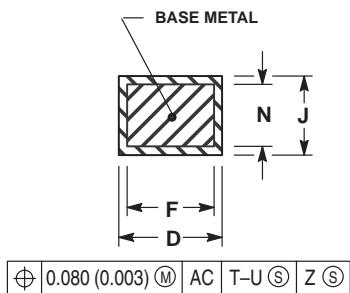
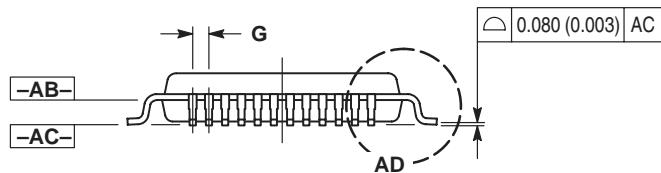
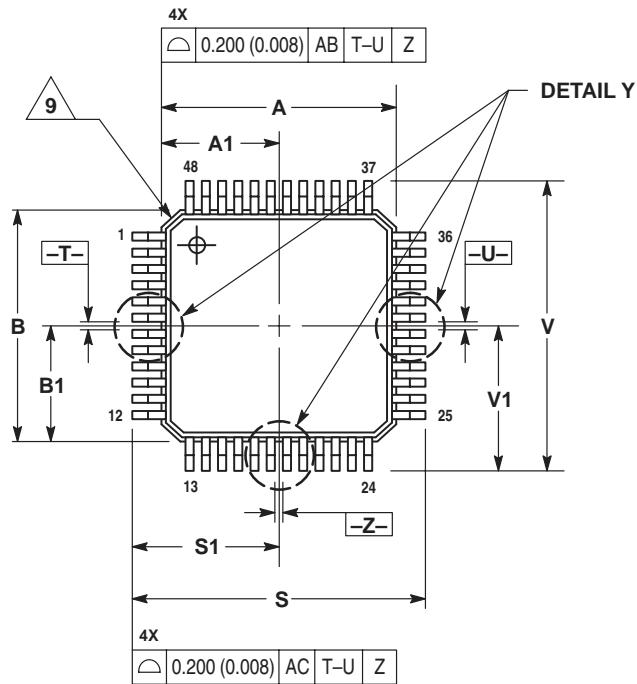
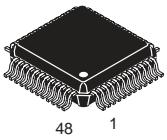


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION R DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
5. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 (0.250).
6. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.003 (0.076) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

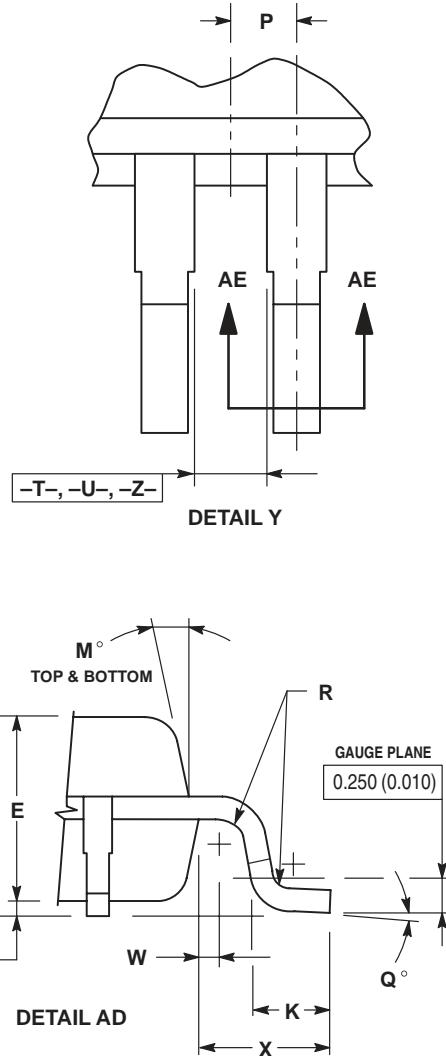
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.684	0.694	17.374	17.627
B	1.183	1.193	30.048	30.302
C	0.175	0.179	4.445	4.547
D	0.026	0.031	0.660	0.787
E	0.058	0.062	1.473	1.574
F	0.165	0.175	4.191	4.445
G	0.050	BSC	1.270	BSC
H	0.169	BSC	4.293	BSC
J	0.014	0.020	0.356	0.508
K	0.625	0.639	15.875	16.231
L	0.770	0.790	19.558	20.066
M	0.148	0.152	3.760	3.861
N	0.148	0.152	3.760	3.861
P	0.390	BSC	9.906	BSC
R	0.416	0.424	10.566	10.770
S	0.157	0.167	3.988	4.242
U	0.105	0.115	2.667	2.921
V	0.868	REF	22.047	REF
W	0.200	BSC	5.080	BSC
Y	0.700	0.710	17.780	18.034

FTA SUFFIX
CASE 932-02
Plastic Package
(TQFP-48)
ISSUE D



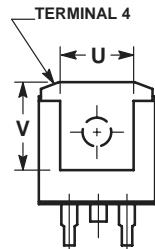
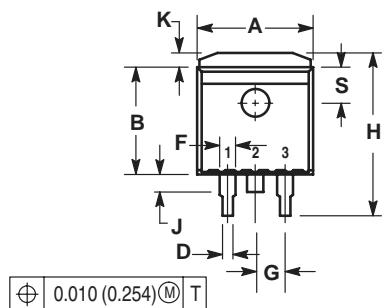
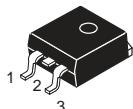
SECTION AE-AE

- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
 4. DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.
 5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -AC-.
 6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO NOT INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
 7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.350 (0.014).
 8. MINIMUM SOLDER PLATE THICKNESS SHALL BE 0.0076 (0.0003).
 9. EXACT SHAPE OF EACH CORNER IS OPTIONAL.



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.000	BSC	0.276	BSC
A1	3.500	BSC	0.138	BSC
B	7.000	BSC	0.276	BSC
B1	3.500	BSC	0.138	BSC
C	1.400	1.600	0.055	0.063
D	0.170	0.270	0.007	0.009
E	1.350	1.450	0.053	0.057
F	0.170	0.230	0.007	0.009
G	0.500	BASIC	0.020	BASIC
H	0.050	0.150	0.002	0.006
J	0.090	0.200	0.004	0.008
K	0.500	0.700	0.020	0.028
M	12 °REF		12 °REF	
N	0.090	0.160	0.004	0.006
P	0.250	BASIC	0.010	BASIC
Q	1 °	5 °	1 °	5 °
R	0.150	0.250	0.006	0.010
S	9.000	BSC	0.354	BSC
S1	4.500	BSC	0.177	BSC
V	9.000	BSC	0.354	BSC
V1	4.500	BSC	0.177	BSC
W	0.200	REF	0.008	REF
X	1.000	REF	0.039	REF

D2T SUFFIX
CASE 936-03
 Plastic Package
 ISSUE B

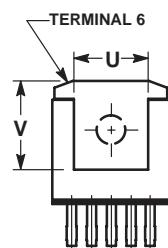
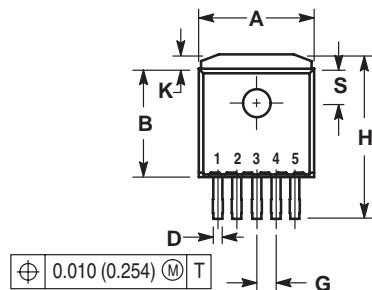
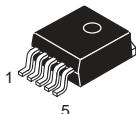


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.
4. DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 4.
5. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.025 (0.635) MAXIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.386	0.403	9.804	10.236
B	0.356	0.368	9.042	9.347
C	0.170	0.180	4.318	4.572
D	0.026	0.036	0.660	0.914
E	0.045	0.055	1.143	1.397
F	0.051	REF	1.295	REF
G	0.100	BSC	2.540	BSC
H	0.539	0.579	13.691	14.707
J	0.125	MAX	3.175	MAX
K	0.050	REF	1.270	REF
L	0.000	0.010	0.000	0.254
M	0.088	0.102	2.235	2.591
N	0.018	0.026	0.457	0.660
P	0.058	0.078	1.473	1.981
R	5°	REF	5°	REF
S	0.116	REF	2.946	REF
U	0.200	MIN	5.080	MIN
V	0.250	MIN	6.350	MIN

D2T SUFFIX
CASE 936A-02
 Plastic Package
 (D²PAK)
 ISSUE A



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.
4. DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 6.
5. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.025 (0.635) MAXIMUM.

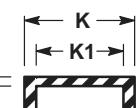
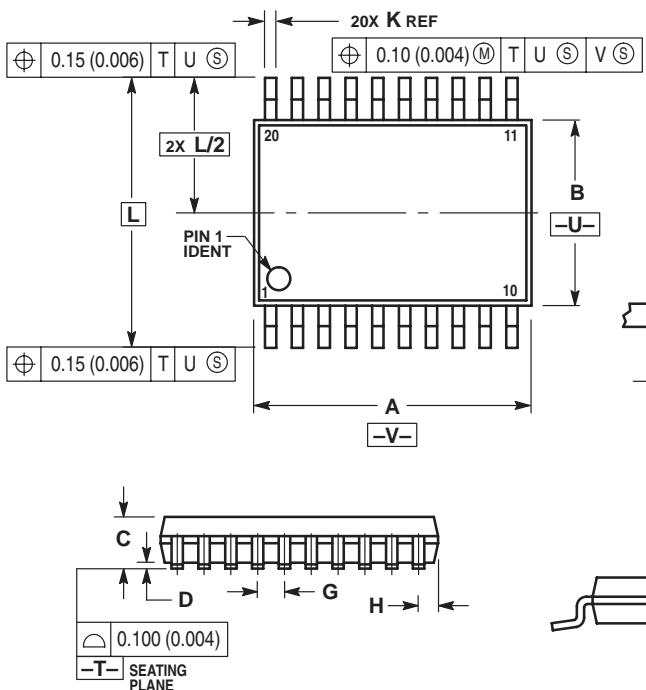
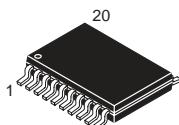
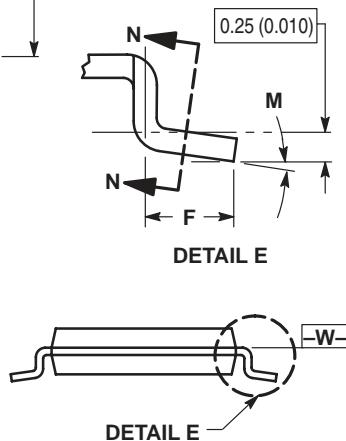
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.386	0.403	9.804	10.236
B	0.356	0.368	9.042	9.347
C	0.170	0.180	4.318	4.572
D	0.026	0.036	0.660	0.914
E	0.045	0.055	1.143	1.397
G	0.067	BSC	1.702	BSC
H	0.539	0.579	13.691	14.707
K	0.050	REF	1.270	REF
L	0.000	0.010	0.000	0.254
M	0.088	0.102	2.235	2.591
N	0.018	0.026	0.457	0.660
P	0.058	0.078	1.473	1.981
R	5°	REF	5°	REF
S	0.116	REF	2.946	REF
U	0.200	MIN	5.080	MIN
V	0.250	MIN	6.350	MIN

DT, DTB SUFFIX**CASE 948E-02**

Plastic Package

(TSSOP-20)

ISSUE A

**SECTION N-N****DETAIL E****NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

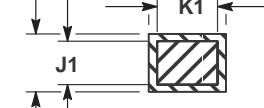
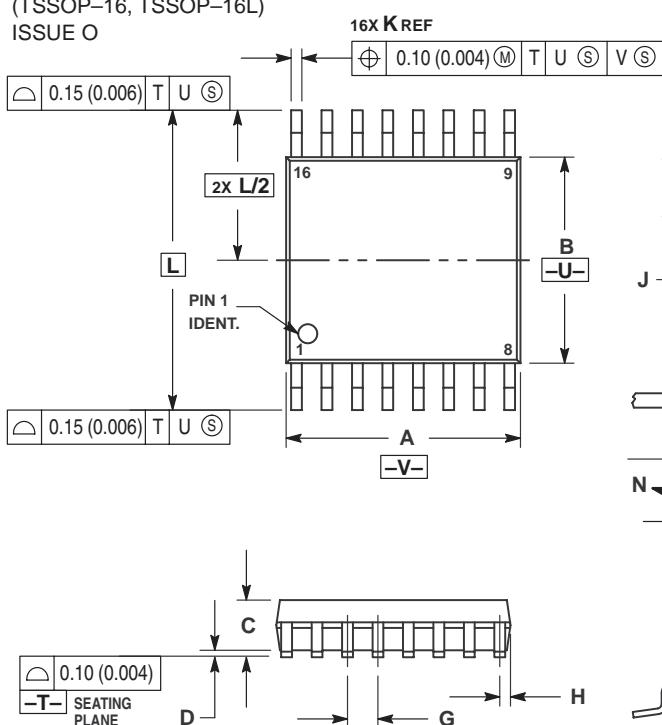
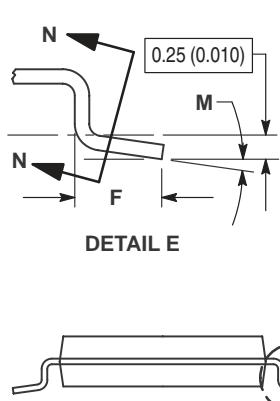
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.40	6.60	0.252	0.260
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC	0.026 BSC	—	—
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC	0.252 BSC	—	—
M	0°	8°	0°	8°

DTB SUFFIX**CASE 948F-01**

Plastic Package

(TSSOP-16, TSSOP-16L)

ISSUE O

**SECTION N-N****DETAIL E****NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC	0.026 BSC	—	—
H	0.18	0.28	0.007	0.011
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC	0.252 BSC	—	—
M	0°	8°	0°	8°

DTB SUFFIX

CASE 948G-01

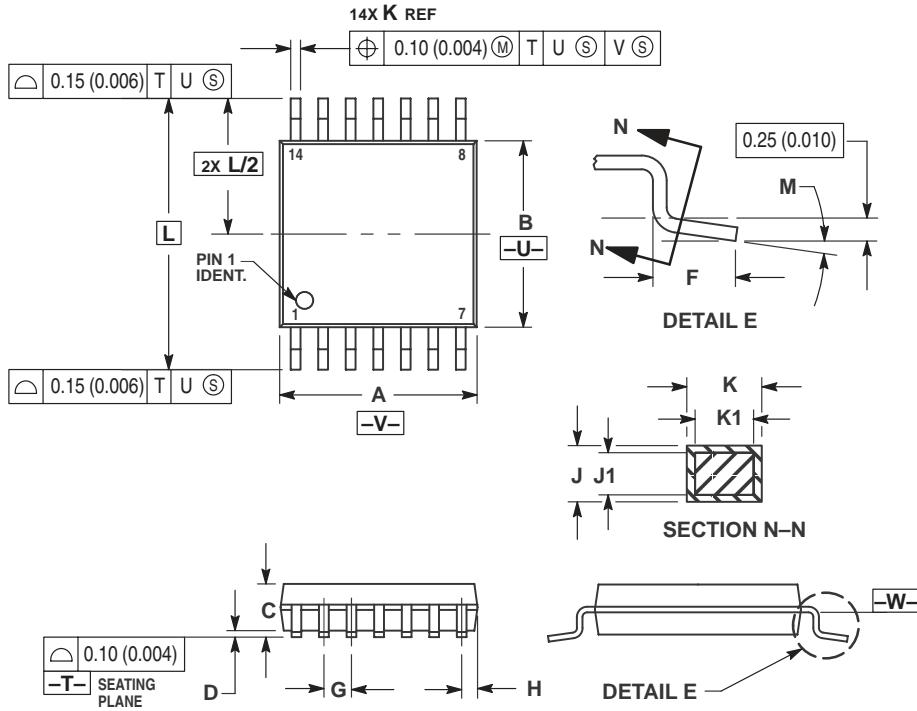
Plastic Package

(TSSOP-14)

ISSUE O



14X K REF

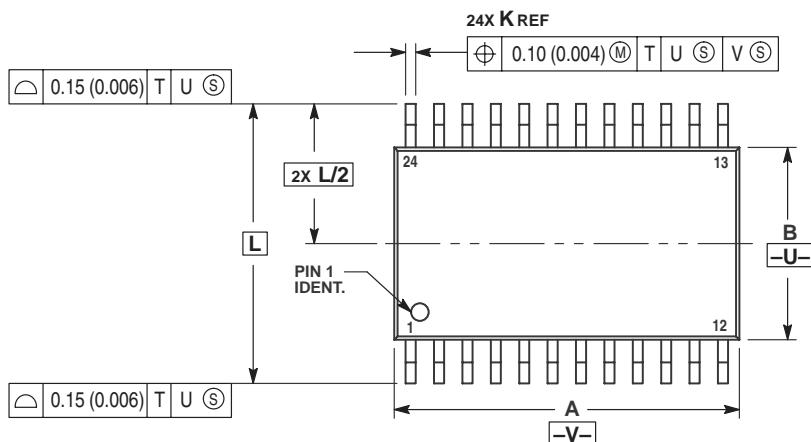
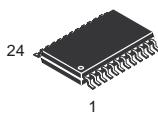


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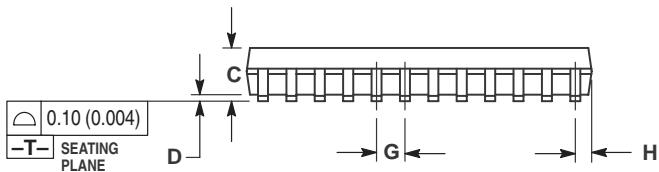
- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2 CONTROLLING DIMENSION: MILLIMETER.
- 3 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 4 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- 5 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 6 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 7 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC	—	0.026 BSC	—
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC	—	0.252 BSC	—
M	0°	8°	0°	8°

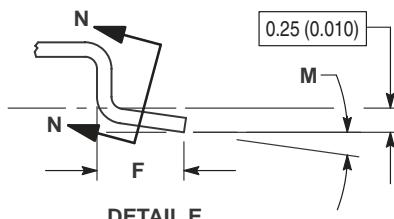
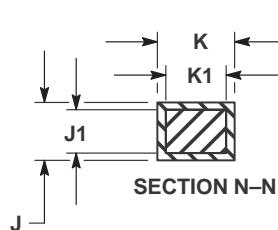
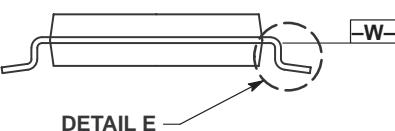
DTB SUFFIX
CASE 948H-01
Plastic Package
ISSUE O



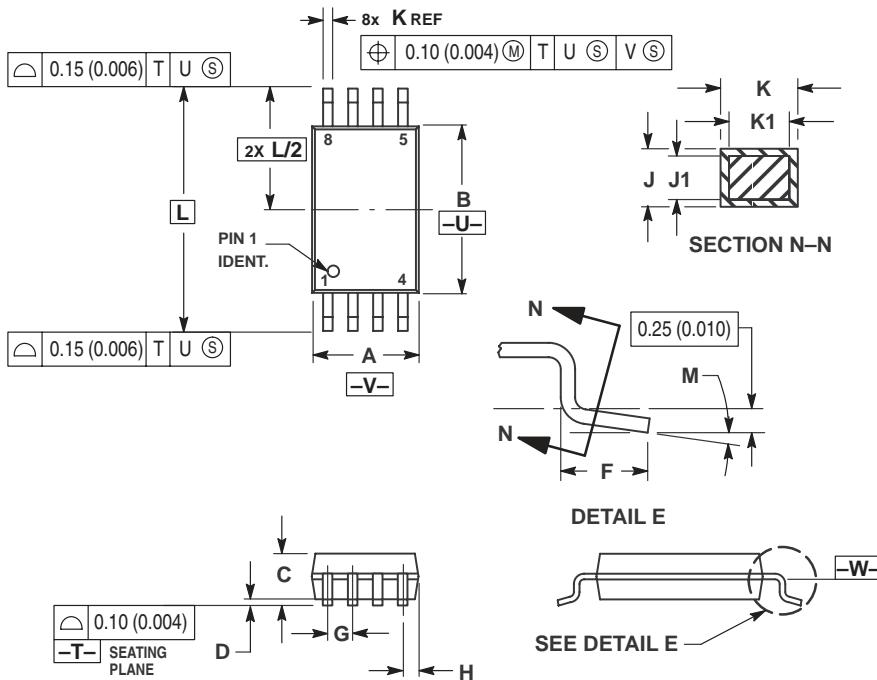
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.70	7.90	0.303	0.311
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC	—	0.026 BSC	—
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC	—	0.252 BSC	—
M	0°	8°	0°	8°



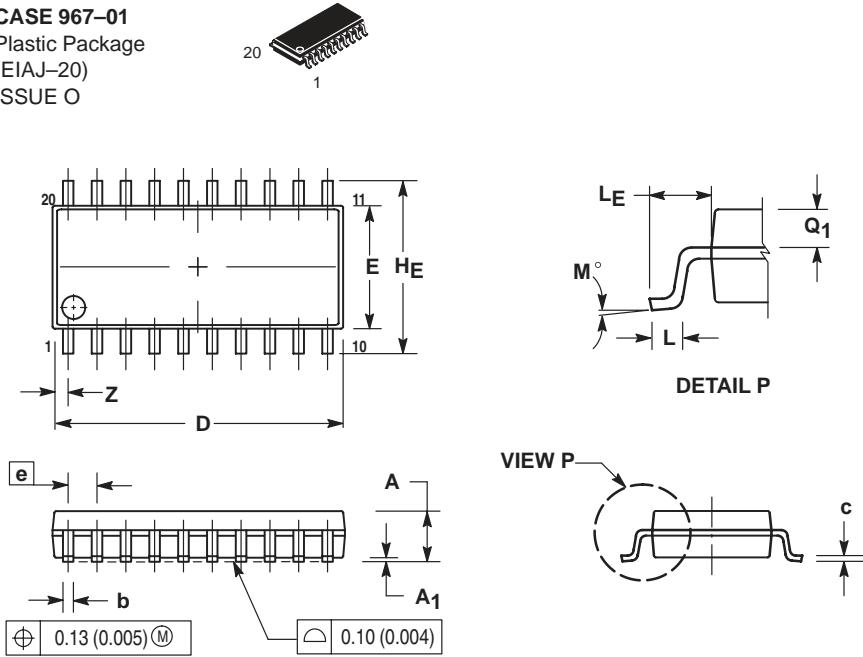
DTB SUFFIX
CASE 948J-01
Plastic Package
(TSSOP-8)
ISSUE O



- NOTES:**
- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - 2 CONTROLLING DIMENSION: MILLIMETER.
 - 3 DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 - 4 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 - 5 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 - 6 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 - 7 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.90	3.10	0.114	0.122
B	4.30	4.50	0.169	0.177
C	—	—	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC	—	0.026 BSC	—
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC	—	0.252 BSC	—
M	0°	8°	0°	8°

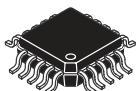
M SUFFIX
CASE 967-01
Plastic Package
(EIAJ-20)
ISSUE O



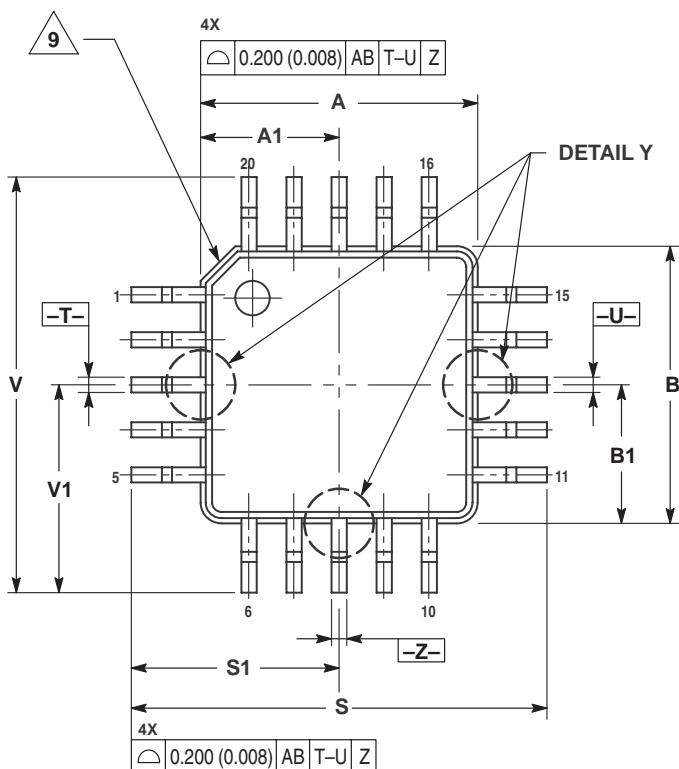
- NOTES:**
- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - 2 CONTROLLING DIMENSION: MILLIMETER.
 - 3 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 - 4 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 - 5 THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	—	—	—	0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	12.35	12.80	0.486	0.504
E	5.10	5.45	0.201	0.215
e	1.27 BSC	—	0.050 BSC	—
H _E	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L _E	1.10	1.50	0.043	0.059
Q ₁	0.70	0.90	0.028	0.035
Z	—	0.81	—	0.032

FTB SUFFIX
CASE 976-01
Plastic Package
(TQFP-20)
ISSUE O



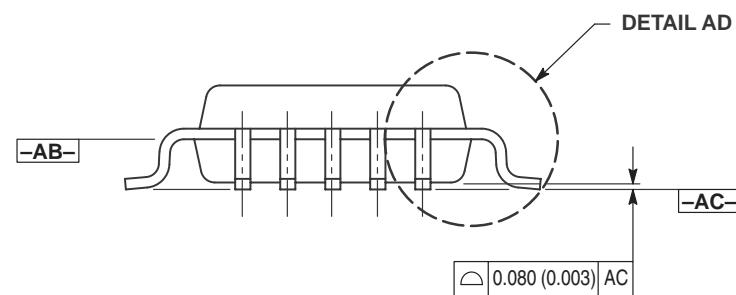
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NOTES:

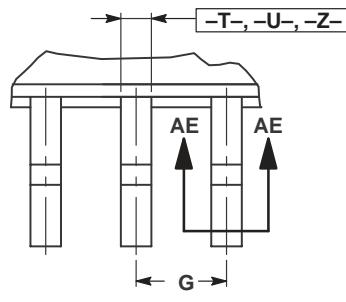
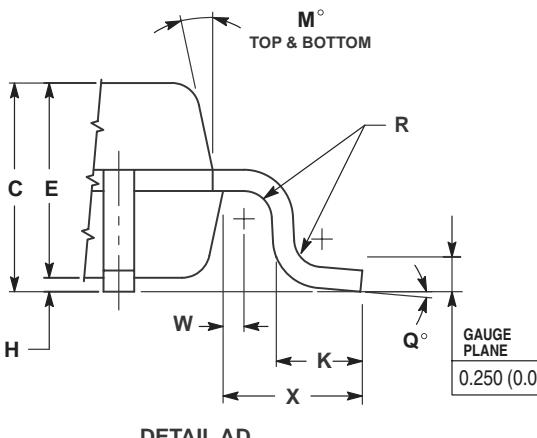
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
4. DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.
5. DIMENSIONS S AND V TO BE DETERMINED AT DATUM PLANE -AC-.
6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.350 (0.014).
8. MINIMUM SOLDER PLATE THICKNESS SHALL BE 0.0076 (0.0003).
9. EXACT SHAPE OF EACH CORNER IS OPTIONAL.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.000	BSC	0.157	BSC
A1	2.000	BSC	0.079	BSC
B	4.000	BSC	0.157	BSC
B1	2.000	BSC	0.079	BSC
C	1.400	1.600	0.055	0.063
D	0.170	0.270	0.007	0.011
E	1.350	1.450	0.053	0.057
F	0.170	0.230	0.007	0.009
G	0.650	BSC	0.026	BSC
H	0.050	0.150	0.002	0.006
J	0.090	0.200	0.004	0.008
K	0.500	0.700	0.020	0.028
M	12°REF	12°REF		
N	0.090	0.160	0.004	0.006
P	0.250	BSC	0.010	BSC
Q	1°	5°	1°	5°
R	0.150	0.250	0.006	0.010
S	6.000	BSC	0.236	BSC
S1	3.000	BSC	0.118	BSC
V	6.000	BSC	0.236	BSC
V1	3.000	BSC	0.118	BSC
W	0.200	REF	0.008	REF
X	1.000	REF	0.039	REF

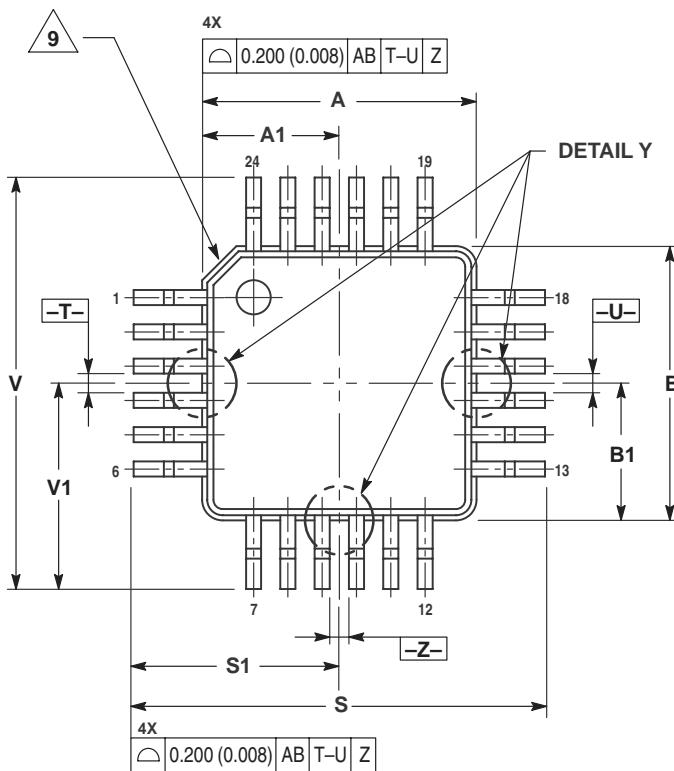
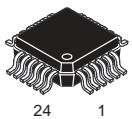


$\oplus 0.080 (0.003) \odot AC T-U \odot Z \odot$

SECTION AE-AE



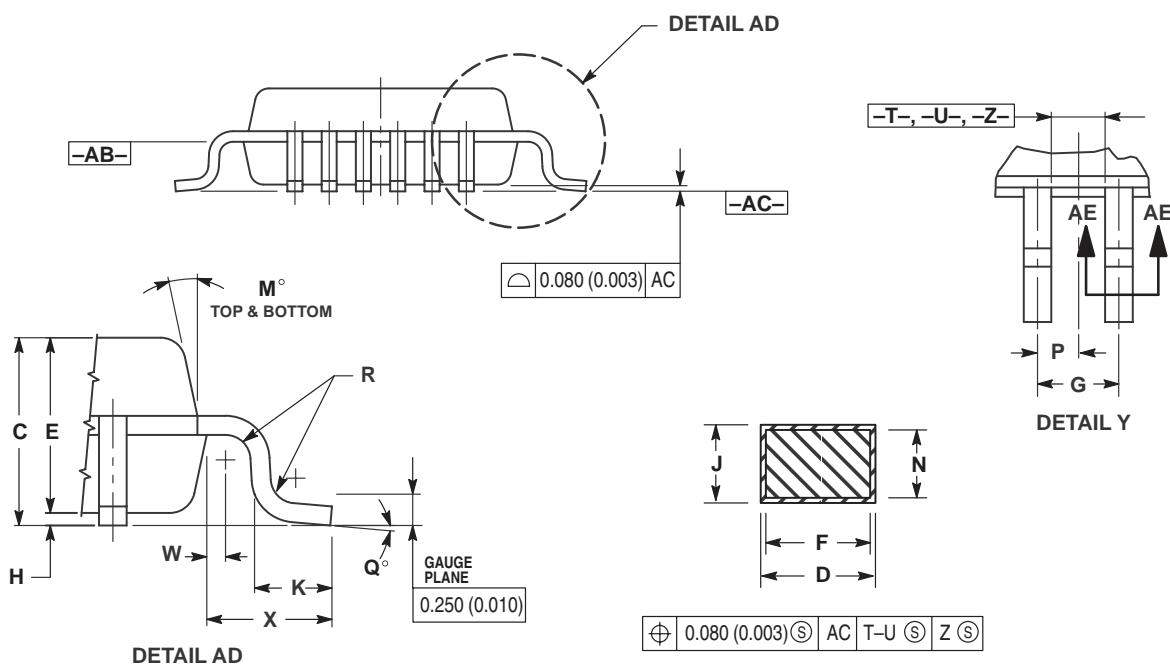
FTA SUFFIX
CASE 977-01
 Plastic Package
 ISSUE O



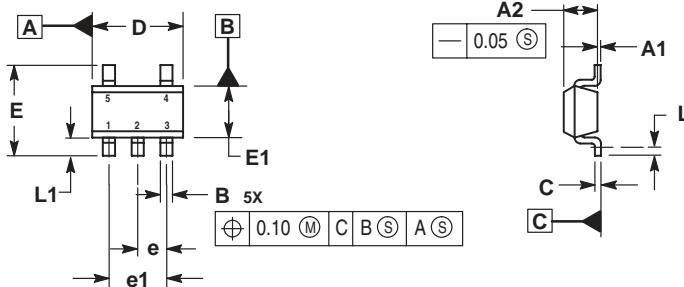
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
4. DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.
5. DIMENSIONS S AND V TO BE DETERMINED AT DATUM PLANE -AC-.
6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.350 (0.014).
8. MINIMUM SOLDER PLATE THICKNESS SHALL BE 0.0076 (0.0003).
9. EXACT SHAPE OF EACH CORNER IS OPTIONAL.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.000	BSC	0.157	BSC
A1	2.000	BSC	0.079	BSC
B	4.000	BSC	0.157	BSC
B1	2.000	BSC	0.079	BSC
C	1.400	1.600	0.055	0.063
D	0.170	0.270	0.007	0.011
E	1.350	1.450	0.053	0.057
F	0.170	0.230	0.007	0.009
G	0.500	BSC	0.020	BSC
H	0.050	0.150	0.002	0.006
J	0.090	0.200	0.004	0.008
K	0.500	0.700	0.020	0.028
M	12°	REF	12°	REF
N	0.090	0.160	0.004	0.006
P	0.250	BSC	0.010	BSC
Q	1°	5°	1°	5°
R	0.150	0.250	0.006	0.010
S	6.000	BSC	0.236	BSC
S1	3.000	BSC	0.118	BSC
V	6.000	BSC	0.236	BSC
V1	3.000	BSC	0.118	BSC
W	0.200	REF	0.008	REF
X	1.000	REF	0.039	REF

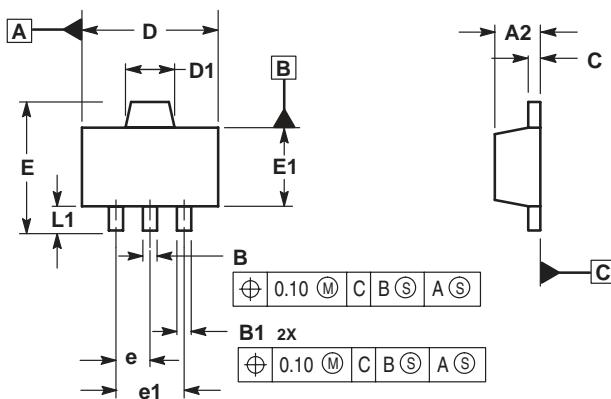


N SUFFIX
CASE 1212-01
 Plastic Package
 (SOT-23)
 ISSUE O



NOTES:
 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES
 PER ASME Y14.5M, 1994.
 3. DATUM C IS A SEATING PLANE.

H SUFFIX
CASE 1213-01
 Plastic Package
 (SOT-89)
 ISSUE O



NOTES:
 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCING
 PER ASME Y14.5M, 1994.
 3. DATUM C IS A SEATING PLANE.